



**Hewlett Packard
Enterprise**
operated by Sophela

intel

Intel Xeon Processors for HPE Servers Selection Criteria

Alexander Golovchenko

HPE Servers Product Manager
Sophela LLC, HPE Master Area Partner

Event Prerequisite

Please fill YOUR OWN criteria list for selecting processors.

What is most important for you? When and why?

— ...

— ...

— ...

— ...

— ...

— ...

— ...

...

A photograph of a man with dark hair and glasses, wearing a yellow ribbed sweater, sitting at a desk. He is looking down at a silver laptop and writing in a green notebook with a pen. A black desk lamp is on the left, and a potted plant is on the right. The background shows a window with vertical blinds.

Agenda

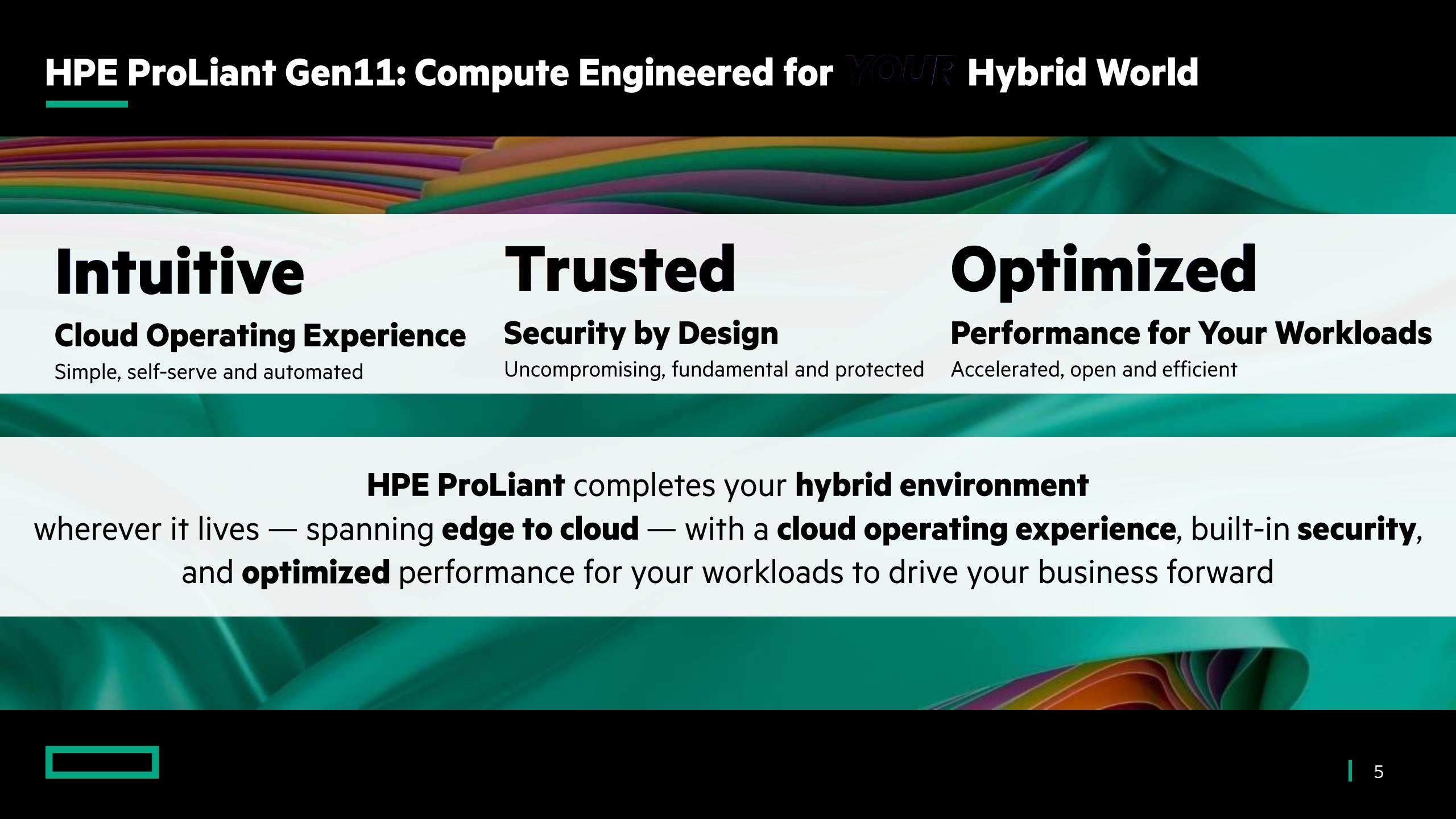
- HPE Servers Gen11 portfolio
- 4th Gen Intel Xeon processors
- How to choose the right processor



HPE Servers Lineup

Product Portfolio

HPE ProLiant Gen11: Compute Engineered for *YOUR* Hybrid World



Intuitive

Cloud Operating Experience

Simple, self-serve and automated

Trusted

Security by Design

Uncompromising, fundamental and protected

Optimized

Performance for Your Workloads

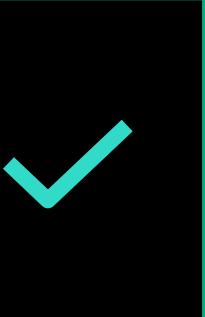
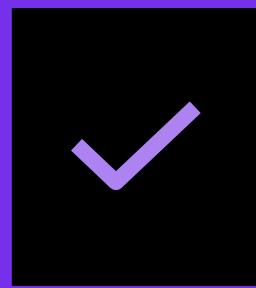
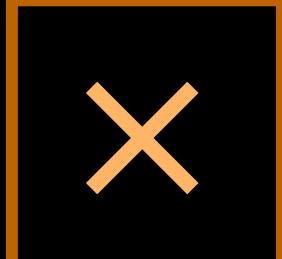
Accelerated, open and efficient

HPE ProLiant completes your **hybrid environment**

wherever it lives — spanning **edge to cloud** — with a **cloud operating experience**, built-in **security**, and **optimized** performance for your workloads to drive your business forward



Where to Position

	Best fit	<ul style="list-style-type: none">• Performance-oriented customers (FSI/Healthcare/etc.)• Workloads benefiting from increased performance:<ul style="list-style-type: none">• AI/ML• Data Analytics• Data Solutions• VDI• Servers Consolidation (one new instead of six old)	Gen11 will be preferred for performance characteristics
	Good fit	<ul style="list-style-type: none">• Platforms/Workloads benefiting from increased performance:<ul style="list-style-type: none">• Hybrid Cloud• Containers	Gen11 will have potential, but Gen10 Plus (v2) may be preference due to cost/benefit for these workloads
	Lowest propensity targets	<ul style="list-style-type: none">• Price sensitive customers<ul style="list-style-type: none">• SMB / transactional customers where performance of Gen10 is sufficient• Customers with limited power capacity per rack	Gen11 is not as likely, as Gen10 / Gen10 Plus (v2) will likely be preferred

Hewlett Packard Enterprise Servers



HPE Compute

Accelerate innovation from edge to cloud with workload-optimized compute for today's data-first, hybrid world



HPE Supercomputing

Empower world-changing innovation and discovery in the Exascale era and beyond, with faster time-to-results and accelerated AI



HPE
ProLiant

HPE
Synergy

HPE
Edgeline

HPE
Superdome

HPE
NonStop

HPE
Apollo

HPE
Cray XD

HPE
Cray EX

HPE
Apollo 4000

HPE
Alletra 4000



HPE Data Storage Servers

Unlock the business value of data to power digital transformation at any scale



HPE ProLiant Gen11 Family



Intel-based Servers

HPE ProLiant DL320 Gen11 Server Overview



TC & Density Optimizes RoBo, Enterprise

1P 1U



Data Collection and Mgmt., Cold Storage, Virtualization, Edge AI, VDI

NOTES:

- Shares board with ML110 Gen11

FEATURE	MAIN Specs
Processors	One 4th Gen Intel Xeon Scalable “ Sapphire Rapids ” processors, up to 32 cores , up to 270 W TDP
Memory	16 DIMM slots, up to 2 TB (16x128GB) DDR5 , 8 channels, 4800 MT/s @1DPC, 4400 MT/s @2DPC
System Bus	PCIe Gen5, 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, LFF LP, EDSFF E3.S 1T
Front Drive Count	Up to 10 SFF SAS/SATA HDD/SSD and NVMe SSD Up to 4 LFF SAS/SATA HDD/SSD Up to 12 LFF SAS/SATA HDD/SSD Up to 4 SFF SAS/SATA HDD/SSD and NVMe SSD, or 8 EDSFF E3.s 1T NVMe SSD, with additional 4 SW or 2 DW GPUs
Boot options	2 x M.2 SATA/NVMe SSD (onboard) 2 x M.2 Hot-Plug/ Internal NVMe SSD (NS204i-u , HW RAID 1)
Storage Controller	Intel VROC SATA/NVMe, Gen11 Controllers (PCIe and OROC)
GPU Support	up to 2 SW rear, 4 SW or 2 DW front
I/O	Up to 2 x16 PCIe Gen5 FHHL slots 1 x16 OCP3.0 slot (PCIe Gen5)
Cooling	Air
Chassis Depth	SFF: 23.8"; 4LFF: 26.2"; 12LFF: 39.2" ; GPU front end: 30.4"

HPE ProLiant DL360 Gen11 Server Overview



Rack Optimized Dense Standard

2P 1U



IT infrastructure, DB Management,
CDN, Intelligent Video Analytics, VDI

Notes:

- Shared board with DL380 and ML350 Gen11
- Chassis is similar, but not the same as DL365 Gen11

FEATURE	MAIN Specs
Processors	Two 4th Gen Intel Xeon or Xeon Max “ Sapphire Rapids ” processors, up to 60 cores , up to 350 W TDP , HBM on Xeon Max SKUs
Memory	32 DIMM sockets, up to 8 TB DDR5 , 8 channels, up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC 64GB HBM per Xeon Max processor
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, LFF LP, EDSFF EC1
Front Drive Count	Up to 10 SFF SAS/SATA HDD/SSD and NVMe SSD Up to 4 LFF SAS/SATA HDD/SSD Up to 20 E3.S 1T EDSFF NVMe SSD
Rear Drive Count	No rear drive
Boot options	Hot-Plug or Non-Hot Plug NS204i-u (2 x M.2 NVMe SSD HW RAID1)
Storage Controller	Intel VROC for SATA or NVMe; Gen11 Controllers (PCIe and OROC)
GPU Support	up to 3 SW
I/O	Up to 3 x16 PCIe Gen5 slots, 1 x FHHL + 2 LP, or 2 FHHL Up to 2 x8 OCP3.0 slots (PCIe Gen5 ; upgradable to x16)
Cooling	Air / Smart Closed-loop Liquid Cooling / Direct Liquid Cooling
Chassis Depth	SFF/EDSFF: 75.3cm (29.65"); LFF: 77.3cm (30.43")

HPE ProLiant DL380 Gen11 Server Overview



Performance Optimized Standard

2P 2U



Collaborative, CRM, Analytics & AI,
VDI, SCM, ERM, Content Management

Notes:

- Shared board with DL360 and ML350 Gen11
- Chassis is similar, but not the same as DL385 Gen11

FEATURE	MAIN Specs
Processors	Two 4th Gen Intel Xeon and Xeon Max “ Sapphire Rapids ” processors, up to 60 cores , up to 350 W TDP , HBM on Xeon Max SKUs
Memory	32 DIMM sockets, up to 8TB, DDR5 , 8 channels, up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, LFF LP, EDSFF EC1
Front Drives	8 or 24 SFF SAS/SATA HDD/SSD and NVMe SSD 8 or 12 LFF SAS/SATA HDD/SSD Up to 36 E3.S 1T EDSFF SSD NVMe
Mid-Tray Drives	8 SFF SAS/SATA HDD/SSD and NVMe SSD 4 LFF SAS/SATA HDD/SSD
Rear Drives	2 or 4 or 6 SFF SAS/SATA HDD/SSD and NVMe SSD 2 or 4 LFF SAS/SATA HDD/SSD
Boot options	Hot-Plug or Non-Hot Plug NS204i-u (2 x M.2 NVMe SSD HW RAID1)
Storage Controller	Intel VROC for SATA or NVMe; Gen11 Controllers (PCIe and OROC)
GPU Support	up to 3 DW to 8 SW
I/O	Up to 8 x16 PCIe Gen5 slots, 6 x FHFL + 2 FHHL Up to 2 x8 OCP3.0 slots (PCIe Gen5; upgradable to x16)
Cooling	Air / Direct Liquid Cooling
Chassis Depth	SFF: 29.6"; LFF: 30.4"; EDSFF: 30.4"

HPE ProLiant DL380a Gen11 Server Overview



GPU Acceleration Optimized

2P 2U



Mid to High-End ML Training and
Inferencing (Enterprise AI/HPC)

Note:

- Both chassis and board is different to DL380 Gen11
- Shared board with Alletra 4110/4120

FEATURE	MAIN Specs
Processors	Two 4th Gen Intel Xeon and Xeon Max “ Sapphire Rapids ” processors, up to 56 cores , up to 350 W TDP, HBM supported on Xeon Max SKUs
Memory	24 DIMM sockets, up to 3 TB (with 128GB DIMMs), DDR5 , 8 channels, up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 support
Drive Carrier	SFF BC, EDSFF EC1
Front Drives	8 SFF NVMe SSD 8 E3.S 1T EDSFF NVMe SSD
Boot options	2 x M.2 Hot-Plug NVMe SSD with NS204i-u Boot Device (HW RAID 1) Rear Hot Plug accessible or internal Non-Hot Plug
Storage Controller	Intel VROC (Virtual RAID on CPU) for direct attach NVMe drives Gen11 Tri-Mode Controllers (PCIe and OROC)
GPU Support	4 DW or 8 SW (future) front
I/O	Up to 4 x16 FHHL PCIe Gen5 slots rear 2 x8 OCP slots (PCIe Gen5 ; upgradable to x16)
Cooling	Air
Chassis Depth	81.6 cm (32.13")

HPE ProLiant DL560 Gen11 Server Overview



The High-Density Scale-Up Server
for Business-Critical Workloads

4P 2U



IMDB, Analytic DB, Virtualization

FEATURE	MAIN SPECS
Processors	Four 4th Gen Intel Xeon “ Sapphire Rapids ” H processors, up to 60 cores , up to 3.7GHz , up to 350 W TDP, up to 4 x 16GT/s UPI
Memory	64 DIMM sockets, up to 16 TB (with 256GB DIMMs) DDR5 , 8 channels, up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, EDSFF
Front Drive Count	Up to 24 SFF SAS/SATA HDD/SSD and NVMe SSD Up to 24 E3.S 1T EDSFF NVMe SSD
Rear Drive Count	No rear drive
Boot options	2 x M.2 Hot-Plug NVMe SSD with NS204i-u Boot Device (HW RAID 1)
Storage Controller	Intel VROC, Gen11 Controllers (PCIe and OROC)
GPU Support	up to 2 DW or 6 SW
I/O	Up to 6 x16 PCIe Gen5 slots, 4 x FHHL (10.5") + 2 FHHL Up to 2 x8 OCP3.0 slots (PCIe Gen5 ; upgradable to x16)
Cooling	Air / Smart Closed-loop Liquid Cooling
Chassis Depth	31.7" (80.6 cm)

HPE ProLiant ML110 Gen11 Server Overview



SMB Optimized
Affordable Server

1P
Tower

IT infrastructure,
Data Management, VDI, ERP/CRM



NOTE:

- Shares motherboard with DL320 Gen11

FEATURE	MAIN Specs
Processors	Two 4 th Gen Intel Xeon "Sapphire Rapids" processors, up to 32 cores , up to 2.5 GHz , up to 185 W TDP
Memory	16 DIMM sockets, up to 1 TB (with 64GB DIMMs), DDR5 , 8 channels, 4800 MT/s @1DPC, 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, LFF LP
Front Drives	Up to 16 SFF SAS/SATA HDD/SSD Hot Plug Up to 8 LFF SAS/SATA HDD/SSD Hot Plug or Non-Hot Plug
Internal Drives	2 x M.2 SATA/NVMe SSD (two 2280/2210 onboard slots)
Networking	Embedded 2-Port 1GbE controller BCM5720, 2 x RJ45 ports rear
Boot options	NS204i-u Boot Device (HW RAID 1) with 2 x M.2 Hot-Plug NVMe SSD
Storage Controller	Intel VROC SATA , Gen11 Controllers (PCIe and OROC)
GPU Support	up to 1 DW to 2 SW
I/O	Up to 4 x16 PCIe Gen5 slots 1 OCP3.0 x16 PCIe Gen5 slot
Chassis Dimensions	46.2cm (H) x 58.7cm (D) x 19.5cm (W)

HPE ProLiant ML350 Gen11 Server Overview



Out of Datacenter
Optimized

**2P
Tower**

IT infrastructure,
Data Management, VDI, ERP/CRM



NOTES:

- Shares board with DL360 and DL380 Gen11

FEATURE	MAIN Specs
Processors	Two 4 th Gen Intel Xeon "Sapphire Rapids" processors, up to 60 cores , up to 350 W TDP, HBM on selected SKUs
Memory	32 DIMM sockets, up to 8 TB DDR5 , 8 channels, 4800 MT/s @1DPC, 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, LFF LP, EDSFF
Front Drive Count	Up to 24 SFF SAS/SATAHDD/SSD NVMe SSD Up to 12 LFF SAS/SATA HDD/SSD Up to 12 E3.S 1T , up to 6 E3.S 2T EDSFF NVMe SSD *
Rear Drive Count	No rear drive
Boot options	2 x M.2 Hot-Plug NVMe SSD with NS204i-u Boot Device (HW RAID 1)
Storage Controller	Gen11 Controllers (PCIe and OROC)
GPU Support	up to 3 SW
I/O	Up to 10 x8 PCIe Gen5 slots Up to 2 x8 OCP3.0 slots (PCIe Gen5; upgradable to x16)
Chassis Depth	28.0"

HPE Synergy 480 Gen11 Compute Module Overview



Composable 2P Blade



Virtualization, Data Management,
Containers, Hybrid Cloud, DevOps

FEATURE	MAIN SPECS
Processors	Two 4 th Gen Intel Xeon "Sapphire Rapids" processors, 16GT/s UPI, up to 56 cores , up to 3.7GHz , up to 350 W TDP
Memory	32 DIMM sockets, up to 8 TB (with 256GB DIMMs) DDR5 , 8 channels, 4800 MT/s @1DPC, 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane
Drive Carrier	SFF Basic Carrier (BC), EDSFF
Front Drive Options	Drive-Less Cage 2 SFF SAS/SATA HDD/SSD and NVMe SSD Tri-Mode Premium Drive Cage 4 SFF SAS/SATA HDD/SSD and NVMe SSD Tri-Mode Premium Drive Cage 4 SFF NVMe SSD Direct Connect Drive Cage 8 E3.S 1T EDSFF NVMe SSD Direct Connect Drive Cage Up to 200 SFF SAS/SATA HDD/SSD with D3940 Storage Modules
Boot Options	2 x M.2 NVMe SSD with NS204i-d Gen11 Boot Controller (HW RAID 1)
Storage Controller	Intel VROC NVMe , SR416ie-m Gen11 Mezzanine Controller
PCI Slots	3 x PCIe 5.0 x16 Mezzanine connectors, two Type C/D and one Type C
Management	HPE iLO 6 Advanced and HPE OneView Advanced (included)

HPE Cray XD220v Server Overview



Multi-Node Shared Infrastructure

1U 2P Node



Purpose-Built and HPC-Optimized
Solution for Exascale Era

FEATURE	MAIN SPECS
Blades	Up to 4 blade servers per HPE Cray v2240 chassis
Processors	Two 4 th Gen Intel Xeon or Xeon Max "Sapphire Rapids" processors, up to 56 cores , up to 3.7GHz , up to 350 W TDP , 16GT/s UPI
Memory	16 DIMM sockets, up to 2 TB (with 128GB DIMMs) DDR5 , 8 channels, up to 4800 MT/s @1DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane
Front Drive Options	2 x SFF Cray carrier Hot Plug NVMe SSD from chassis drive cage 1 x M.2 2280/22110 NVMe SSD on the M.2 Mezz Riser Kit
PCI Slots	2 x16 PCIe 5.0 Low Profile slots 1 OCP3.0 x16 PCIe 5.0 slot
Management	HPE Cray XD BMC with Hardware Root of Trust
Cooling	Air / Direct Liquid Cooling
Chassis Depth	38.43" (91.6 cm)

HPE Cray XD670 Server Overview



Top-Performing GPU-Accelerated Server

5U 2P 8GPU



Large Model AI Training
and Deep Learning

FEATURE	MAIN SPECS
Processors	Two 4th Gen Intel Xeon “ Sapphire Rapids ” processors, up to 56 cores , up to 350 W TDP
Accelerators	8 NVIDIA H100 80GB SXM5 GPU
Memory	32 DIMM sockets, up to 4TB (with 128GB DIMMs), DDR5 , 8 channels, up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	3 rd part SFF carrier
Front Drives	8 SFF NVMe SSD
Boot options	Non-Hot Plug 4 x M.2 NVMe SSD 22110 HW RAID
Storage Controller	HW RAID Controllers (PCIe)
I/O	Up to 12 x16 PCIe Gen5 Low Profile slots
Chassis Depth	33.75" (85.7cm)

HPE Alletra 4110 Data Storage Server Overview



All-NVMe Data Storage Server
2P 1U



Data Stores for ML, Distributed and NoSQL DB, High-Performance SDS

Notes:

- Shared board with Alletra 4120 and ProLiant DL380a Gen11
- EDSFF chassis is similar, but a bit different to DL360 Gen11, 20EDSFF x4 drive backplane is the same

FEATURE	MAIN Specs
Processors	Two 4th Gen Intel Xeon “ Sapphire Rapids ” processors, up to 48 cores , up to 350 W TDP, up to 3.7 GHz, up to 4 UPI
Memory	24 DIMM sockets, up to 6 TB DDR5 , 8 channels, 2-2-1-1 configuration, up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, EDSFF EC1
Front Drive	Up to 20 SFF NVMe SSD Up to 20 E3.S 1T EDSFF NVMe SSD
Rear Drive	No rear drive
Boot options	Non-Hot Plug NS204i-u (2 x 480GB M.2 NVMe SSD HW RAID1) or Non-Hot Plug Pass Thru Board (2 x M.2 NVMe SSD)
I/O	2 x16 PCIe Gen5 FHHL slots 2 x16 OCP slots (PCIe Gen5)
Cooling	Air / Smart Liquid Cooling Closed-Loop Solution
Chassis Depth	SFF: 84.2cm (33.16"); EDSFF: 73.3cm (28.85")

HPE Alletra 4120 Data Storage Server Overview



Hybrid-NVMe Data Storage Server

2P 2U



Active Analytics Data Lakes, Converged DP, File and Object SDS, Deep Archives

Notes:

- Shared board with Alletra 4110 and ProLiant DL380a Gen11
- Chassis is similar in front, but different in rear to Apollo 4200 Gen10

FEATURE	MAIN Specs
Processors	One or Two 4th Gen Intel Xeon "Sapphire Rapids" processors, up to 48 cores , up to 350 W TDP, up to 3.7 GHz
Memory	24 DIMM sockets, up to 6 TB DDR5 , 8 channels, 2-2-1-1 configuration, up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, LFF LP, EDSFF EC1
Front Drive Count	Up to 24 LFF SAS/SATA HDD/SSD Up to 48 SFF SAS/SATA HDD/SSD
Rear Drive Count	2 or 4 LFF SAS/SATA HDD/SSD (with 24LFF chassis only) 6 SFF SAS/SATA HDD/SSD and NVMe SSD 12 EDSFF E3.S 1T NVMe SSD
Boot options	Non-Hot Plug NS204i-u (2 x 480GB M.2 NVMe SSD HW RAID1) or Non-Hot Plug Pass Thru Board (2 x M.2 NVMe SSD)
Storage Controller	Gen11 Controllers (PCIe and OROC), no expander design
I/O	Up to 8 x16 PCIe Gen5 FHHL slots Up to 2 x8 OCP3.0 slots (PCIe Gen5 ; upgradable to x16)
Cooling	Air
Chassis Depth	SFF/LFF: 81.3 (32.0")

HPE Compute Scale-up Server 3200* Overview



Modular, reliable and secure compute platforms
for critical applications, analytics, HPC and AI

4..16P 5..20U



SAP HANA, Oracle, SQL Server, Epic

FEATURE	MAIN Specs
Processors	4 to 16 4th Gen Intel Xeon "Sapphire Rapids" processors, up to 60 cores , up to 3.7GHz , up to 350 W TDP, 3 or 4 x 16GT/s UPI
Memory	up to 256 DIMM sockets, up to 32 TB (w/128GB DIMMs) DDR5 , 8 ch., up to 4800 MT/s @1DPC, up to 4400 MT/s @2DPC
System Bus	PCIe Gen5 , 32GT/s (~4GB/s) per lane, CXL 1.1 supported
Drive Carrier	SFF BC, EDSFF EC1
Rear Drives	up to 96 EDSFF NVMe SSD up to 40 SFF SAS/SATA HDD/SSD and NVMe SSD
I/O	up to 64 x16 PCIe Gen5 slots
GPU	up to 16 DW

* - announced, not launched yet

New Intel Xeon Processors

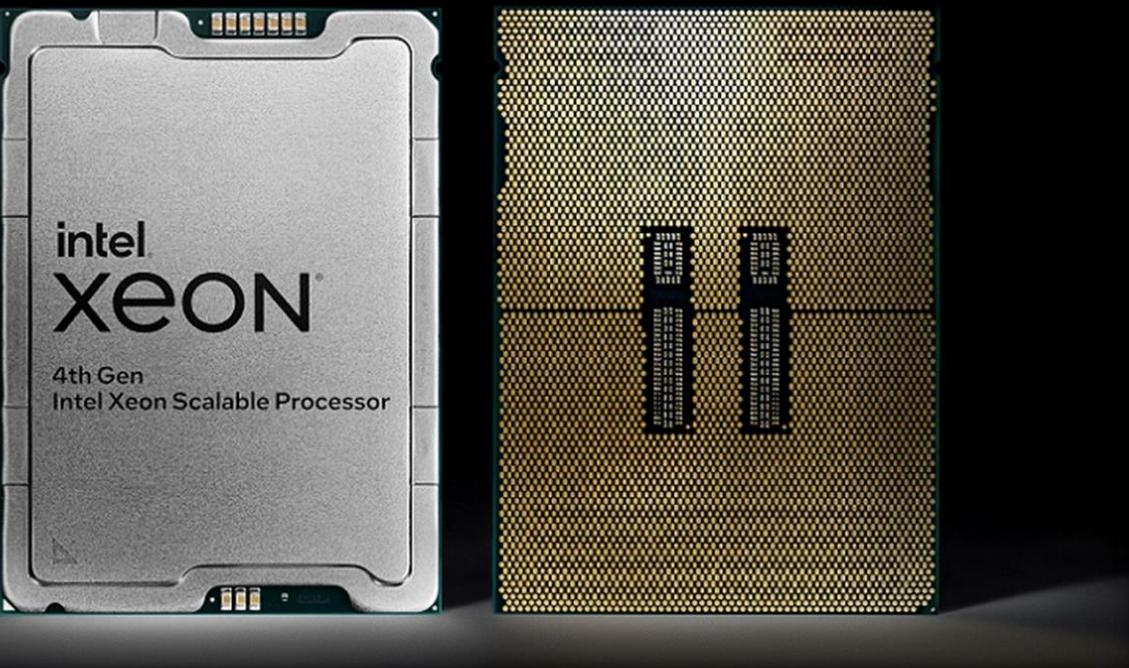
Features and Technologies Overview



4th Gen Intel Xeon Scalable Processors

“Sapphire Rapids”

Product Information



intel

Intel's Most Feature Rich Server Platform

4th Gen Intel® Xeon® Scalable Processors and Intel® Xeon® CPU Max Series Processors

New Integrated IP Accelerators

Increased I/O Bandwidth with PCIe 5.0

Compute Express Link (CXL) 1.1

4th Gen Intel Xeon Scalable Processor

Intel Xeon CPU Max Series

Intel® In-Memory Analytics Accelerator
Intel® Data Streaming Accelerator
Intel® Dynamic Load Balancer
Intel® QuickAssist Technology



PCIe 5.0/4.0 Up to 80 Lanes



1 to 8 Socket Support



Intel® In-field Scan **
Intel® Seamless Firmware Update



High Bandwidth Memory Support



Intel® Optane™ Persistent Memory 300 Series

Intel® Agilex™ FPGAs

Intel® Data Center GPU Max Series
Intel® Data Center GPU Flex Series

Intel® Infrastructure Processing Unit (Intel® IPU)



8 DMI 4.0 LINKS



Intel® Advanced Matrix Extensions (AMX)
Accelerating Interfacing Architecture (AiA)



Intel® Advanced Vector Extensions for vRAN



Enhanced Intel® Software Guard Extensions



8 Channel DDR5
Up To 4800 MT/s (1DPC)
Up To 4400 MT/s (2DPC)



16 DIMMs per Socket
New RAS features (Enhanced ECC, Error Check & Scrub)



Intel® Ultra Path Interconnect (Up to 4 Links @ 16 GT/s)



Optimized Power Mode

New Integrated ISA Accelerators

HW-Enhanced Security

Increased Memory Bandwidth with DDR5

Increased Inter-Socket Bandwidth with UPI 2.0

intel XEON Accelerate with Xeon

* Enabled for WorkStation + vPro Skus ONLY
** Intel In-Field Scan is a new capability available through select providers in 2023

Source: Intel



intel

Driving Platform Innovation

Broad Ecosystem Readiness To Deploy Today

DDR5

- 8ch DDR5 (per CPU): up to 4800 MT/s
- 9x4 RDIMM support
- 3DS RDIMM support
- New RAS features
 - Enhanced ECC
 - Error Check and Scrub
- Both 2DPC and 1DPC today

Up to **1.5x**
higher memory bandwidth
vs. DDR4

PCIe 5.0

- 80 lanes
- Improved DDIO and QoS capabilities
- X2 bifurcation @ Gen 4

Up to **2x**
Increased I/O Bandwidth
vs. PCIe 4.0

CXL 1.1

- Next Gen I/O
- Up to 4 CXL devices supported per CPU
- Type 1 device: CXL.io and CXL.cache (e.g., SmartNIC)
- Type 2 device: CXL.io, CXL.cache and CXL.mem (e.g., GPU, ASIC, FPGA)

Type 1
and Type 2

UPI 2.0

- Up to 4 UPI links @ 16 GT/s
- New 8S-4 UPI Performance Optimized Topology

Up to **1.9x**
Increased inter-socket
bandwidth vs. prior gen

intel® XEON® Accelerate with Xeon

See backup for workloads and configurations. Results may vary.

Source: Intel

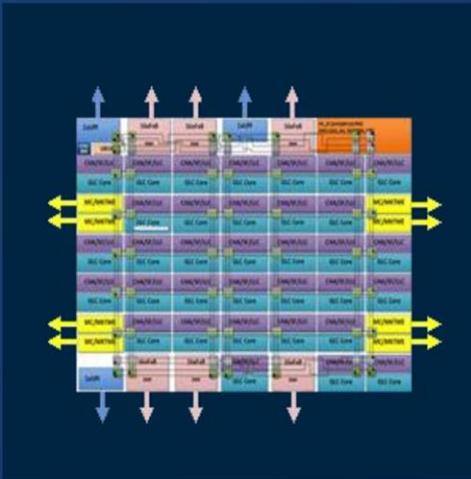


intel

Unique Die Packages for Unique Market Needs

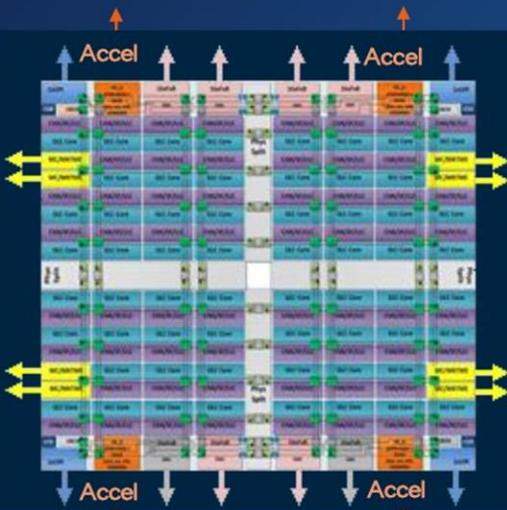
Intel® Xeon® Die Package Architecture

4th Gen Intel Xeon processor - MCC
Monolithic Architecture



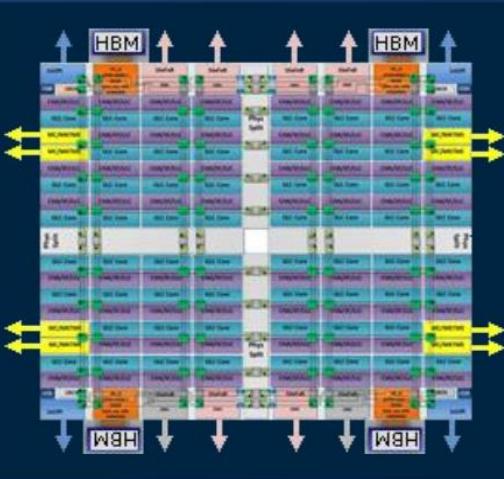
Mainstream Market, Higher Frequencies,
Lower Latency

4th Gen Intel Xeon processor - XCC
4 Tile Architecture



Socket Scalability,
Highest Core Count

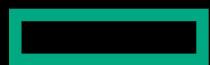
Intel Xeon CPU Max Series
4 Tile Architecture



HPC and Memory Bandwidth
Bound Applications

intel
XEON Accelerate with Xeon

Source: Intel



intel

Die Package Details

Features	4 th Gen Intel® Xeon® Scalable Processors		Intel® Xeon® CPU Max Series
	Medium Core Count (MCC)	Extreme Core Count (XCC)	High Bandwidth Memory (HBM)
Die Construction	1 monolithic chip	4 tiles connected using MDF over Intel Embedded Multi-die Interconnect Bridge (EMIB)	4 tiles connected using MDF over Intel Embedded Multi-die Interconnect Bridge (EMIB)
Core Count	Up to 32 active cores	Up to 60 active cores	Up to 56 active cores
TDP Range	125 to 350W	225 to 350W	350W
Memory	DDR5 @ 4800 (1DPC), 4400 (2DPC), 16 Gb DRAM, 8 Channels Intel® Optane™ PMem 300 (Crow Pass) @4400 MT/s		DDR5 @ 4800 (1DPC), 4400 (2DPC), 8Channels 64 GB HBM2e memory with up to 1.14 GB/core
Intel UPI	UPI 2.0 @ 16 GT/s, up to 3 Ultra Path Interconnects	UPI 2.0 @ 16 GT/s, up to 4 Ultra Path Interconnects	UPI 2.0 @ 16 GT/s, up to 4 Ultra Path Interconnects
Scalability	1 Socket, 2 Socket, 4 Socket	1 Socket, 2 Socket, 4 Socket, 8 Socket	1 Socket, 2 Socket
PCIe/Compute Express Link	PCIe 5.0 (80 lanes), Up to 4 devices supported via Compute Express Link (CXL) 1.1		
Security	Intel® SGX Minimum Enclave Page Cache (EPC) size 256 MB		Intel® SGX (Flat mode only)
Integrated IP Accelerators	Intel® QAT, DLB (up to 2 devices each) Intel® DSA, IAA (1 device each)	Intel® QAT, DLB, IAA, DSA (up to 4 devices each)	Intel® DSA (4 devices)

intel® XEON® Accelerate with Xeon



intel

Intel® Accelerator Engines

Most Built-in Accelerators of any CPU on the market providing customers with increased **performance**, **costs savings** and **sustainability** advantages for the biggest and fastest-growing workloads

Intel® AI Engines

Intel® Advanced Matrix Extensions (Intel® AMX)

Intel® Advanced Vector Extensions 512 (Intel® AVX-512)

Intel® Deep Learning Boost (Intel® DL Boost)

Intel® Security Engines

Intel® Control-Flow Enforcement Technology (Intel® CET)

Intel® Crypto Acceleration

Intel® Software Guard Extensions (Intel® SGX)

Intel® Trust Domain Extensions (Intel® TDX)

Intel® QuickAssist Technology (Intel® QAT)

Intel® HPC Engines

Intel® Advanced Vector Extensions 512 (Intel® AVX-512)

Intel® Advanced Matrix Extensions (Intel® AMX)

Intel® Data Streaming Accelerator (Intel® DSA)

Intel® QuickAssist Technology (Intel® QAT)

Intel® Network Engines

Intel® QuickAssist Technology (Intel® QAT)

Intel® Dynamic Load Balancer (Intel® DLB)

Intel® Data Streaming Accelerator (Intel® DSA)

Intel® Advanced Vector Extensions (Intel® AVX) for vRAN

Intel® vRAN Boost

Intel® Speed Select Technology (Intel® SST)

Intel® Analytics Engines

Intel® In-memory Analytics Accelerator (Intel® IAA)

Intel® Data Streaming Accelerator (Intel® DSA)

Intel® Advanced Vector Extensions 512 (Intel® AVX-512)

Intel® QuickAssist Technology (Intel® QAT)

Intel® Storage Engines

Intel® Data Streaming Accelerator (Intel® DSA)

Intel® QuickAssist Technology (Intel® QAT)

Intel® In-memory Analytics Accelerator (Intel® IAA)

Intel® Data Direct I/O (Intel® DDIO)

Intel® Advanced Vector Extensions 512 (Intel® AVX-512)

Intel® Crypto Acceleration

intel
XEON Accelerate with Xeon

Supported in 4th Gen Intel® Xeon® Scalable processors and Intel® Xeon® CPU Max Series processors

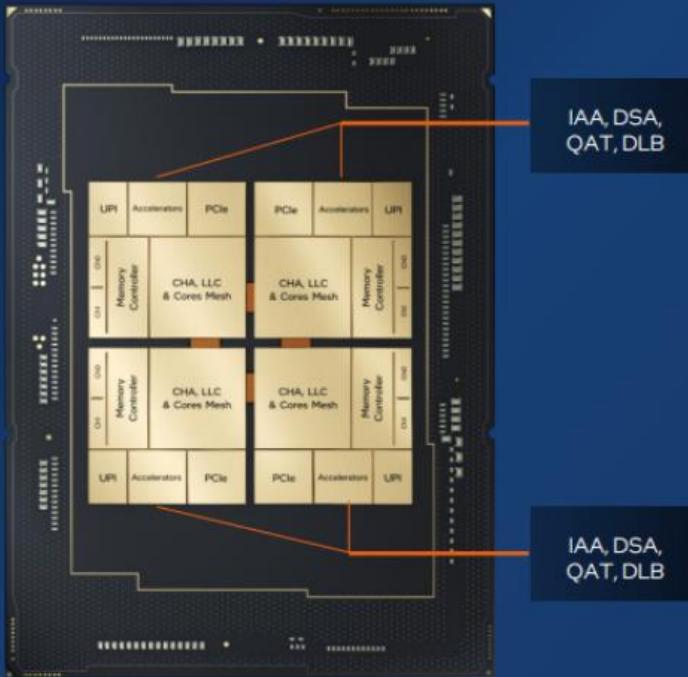
Source: Intel



intel

Enabling the Intel® Accelerator Engines

Tools for developers to take advantage and deploy today



Intel® Advanced Matrix Extensions (Intel® AMX)

- TensorFlow
- PyTorch
- ONNX Runtime
- OpenVINO
- oneDNN (Intel oneAPI)



Intel® Advanced Vector Extensions (Intel® AVX) for vRAN

- FlexRAN
- Data Plane dev Kit (DPDK)*



Intel® In-memory Analytics Accelerator (Intel® IAA)

- Intel Query Processing Library



Intel® Data Streaming Accelerator (Intel® DSA)

- Storage Perf Dev Kit (SPDK)*
- Data Plane Dev Kit (DPDK)*



Intel® QuickAssist Technology (Intel® QAT)

- QATzip* (Intel lib)
- OpenSSL**
- Boring SSL



Intel® Dynamic Load Balancer (Intel® DLB)

- VPP IPsec
- Data Plane Dev Kit (DPDK)*

intel
xeon Accelerate with Xeon

*Intel open-source library (not part of stock SW).

**Difference between Intel version and stock version.

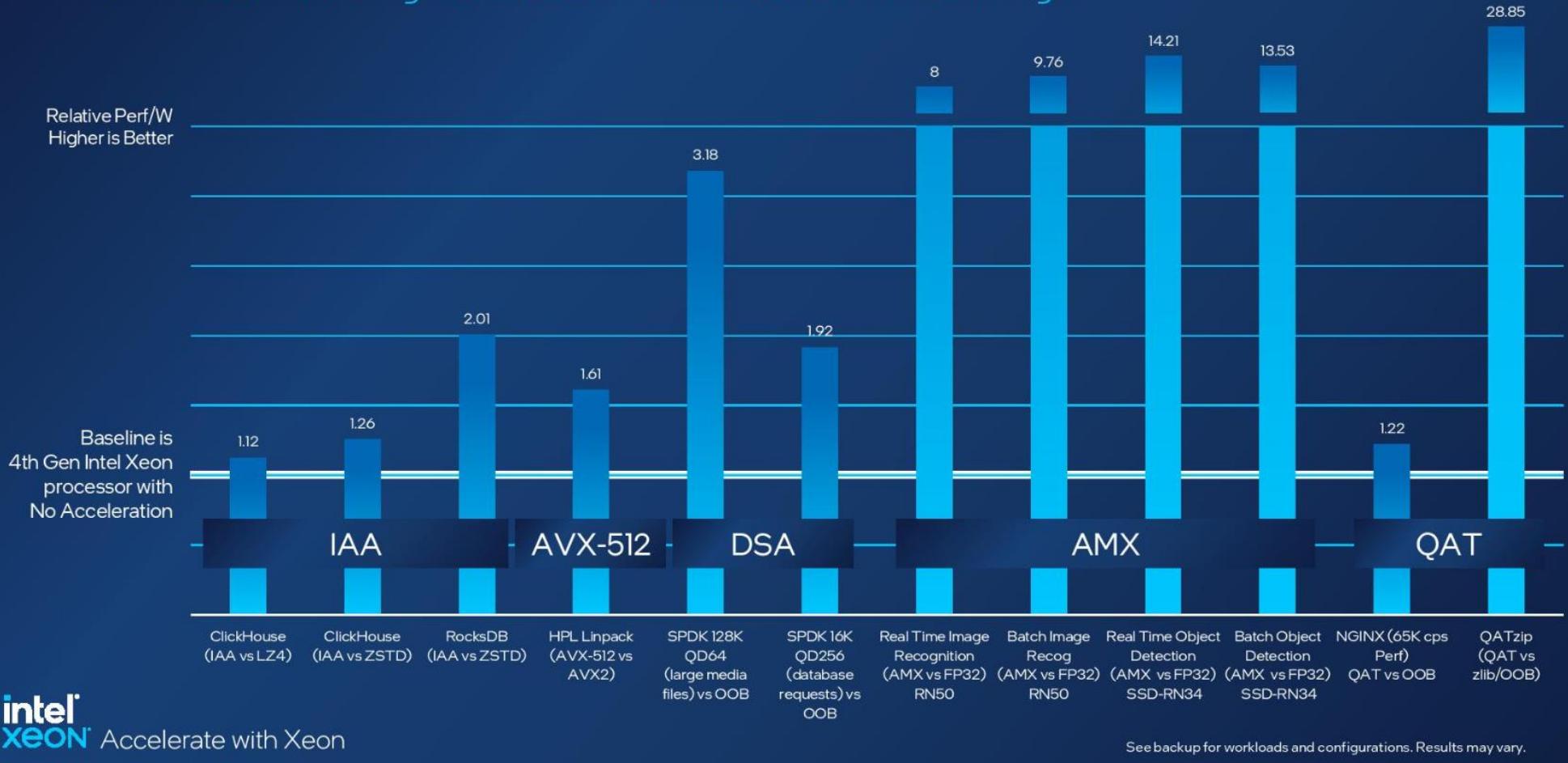
***Intel® OPL and *Intel® DML in open-source beta, v1.0.0 coming shortly.

Source: Intel

intel

A More Energy Efficient Server Architecture

Intel® Accelerator Engines Raise Performance Per Watt Ceilings

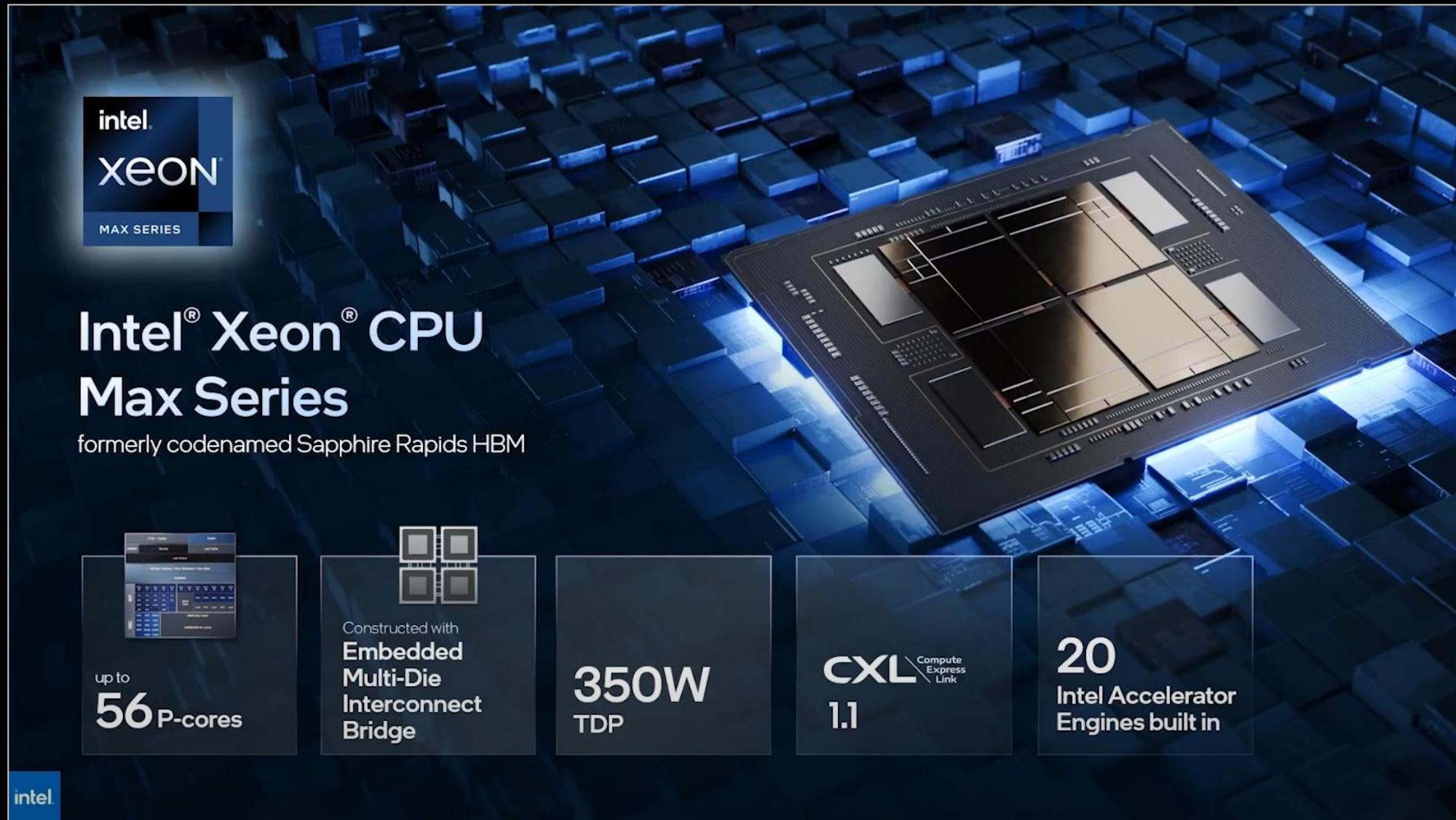


intel
XEON Accelerate with Xeon

Source: Intel



intel



**intel.
xeon
MAX SERIES**

Intel® Xeon® CPU Max Series

formerly codenamed Sapphire Rapids HBM

up to **56 P-cores**

Constructed with
Embedded Multi-Die Interconnect Bridge

350W TDP

CXL 1.1

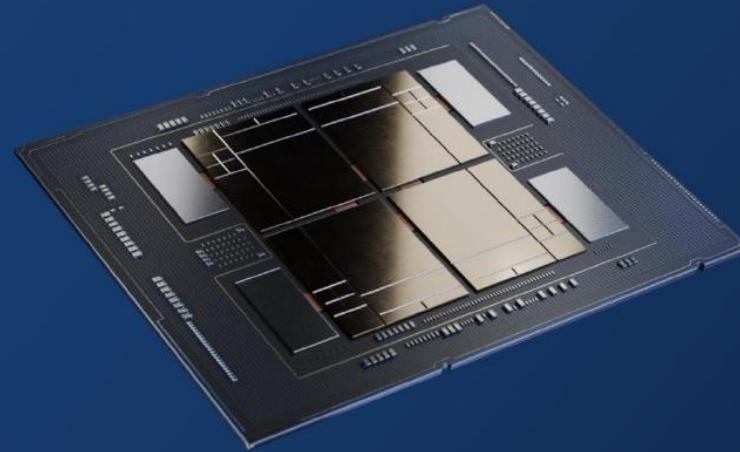
20 Intel Accelerator Engines built in



intel



Only x86 CPU with High Bandwidth Memory (HBM)



Memory modes

64GB HBM2e	up to 112.5MB shared LLC	DDR5 8 channels per CPU @ 4800MTS (IDPC) /16 DIMMs per socket
---------------	--------------------------	---

~1TB/s memory BW

>1GB/core HBM memory capacity

HBM Only

Workloads ≤ 64GB capacity

No code change
No DDR

System boots and operates with HBM only

HBM

HBM Flat Mode

Flat Mem Regions w/ HBM & DRAM
Workloads > 64GB capacity

Code change may be needed to optimize perf

Provides flexibility for applications that require large memory capacity



HBM Caching Mode

DRAM backed cache
Improved performance for workloads > 64GB capacity

No code change
HBM Caches DDR

Blend of both prior modes. Whole applications may fit in HBM cache
Blurs line between cache and memory



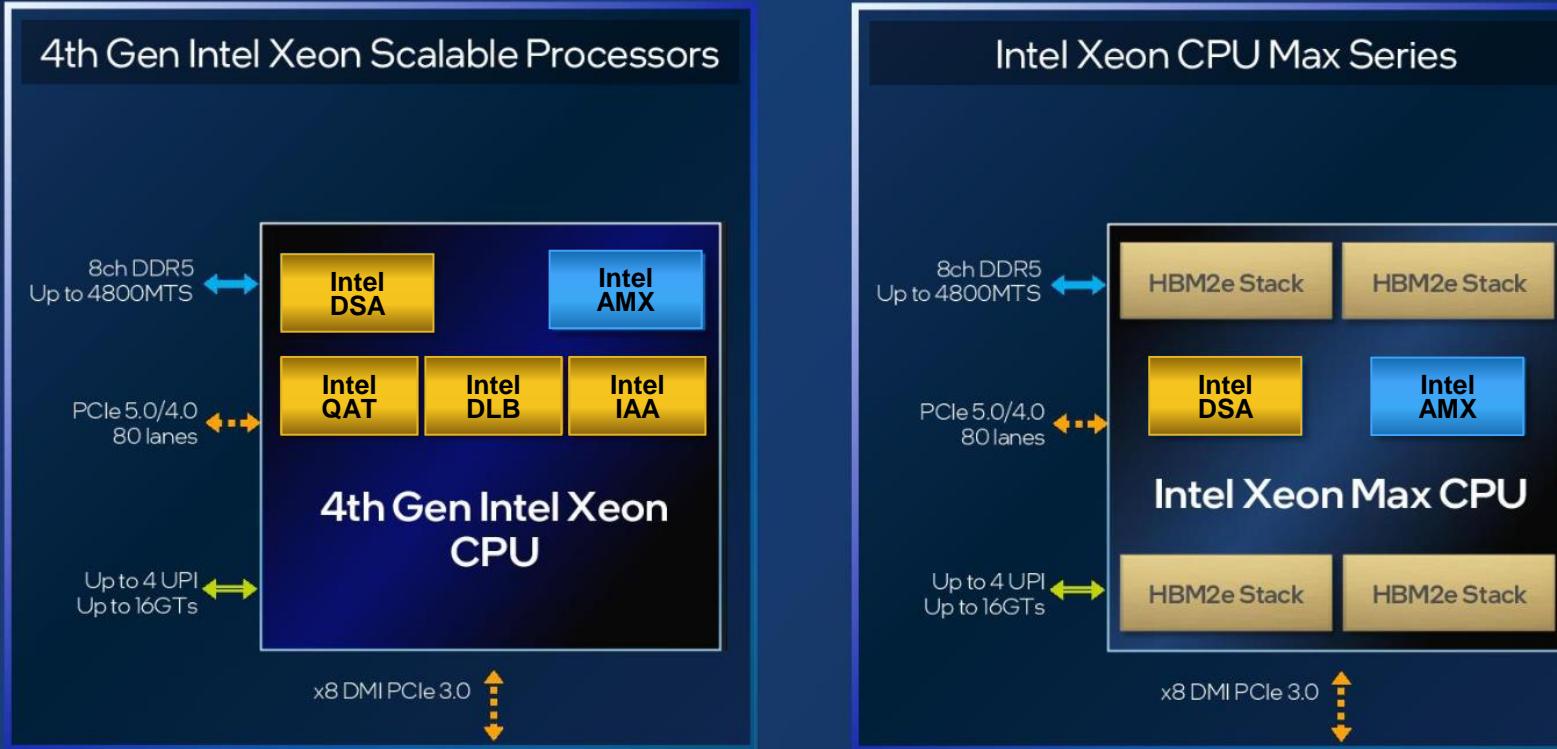
intel
Xeon Accelerate with Xeon

Source: Intel



intel

Intel® Xeon Processors – built on the same foundation

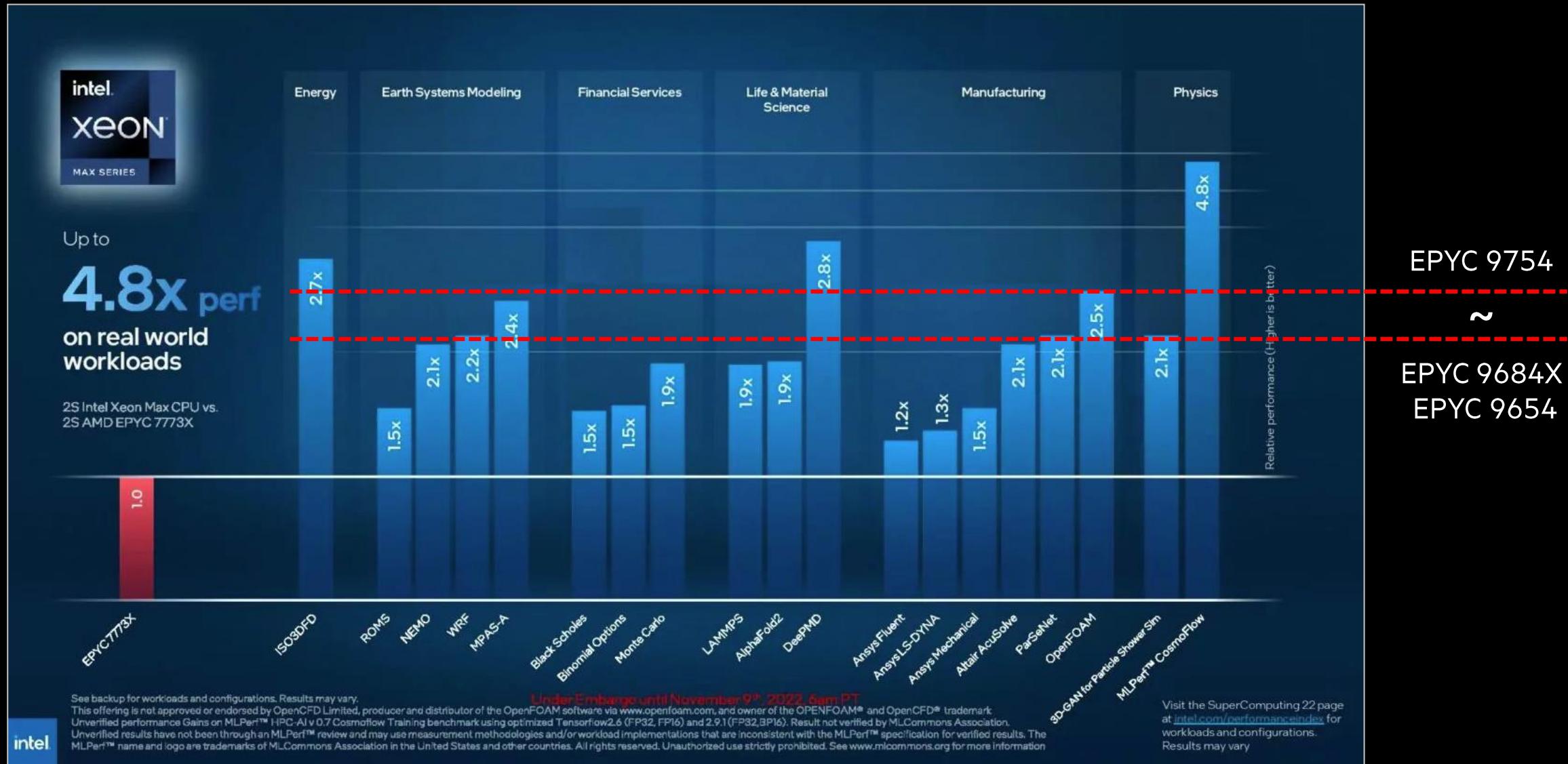


intel
xeon® Accelerate with Xeon

Source: Intel



intel



intel

Source: Intel

4th Gen Intel® Xeon® CPUs vs AMD 4th Gen EPYC

32C Broad Workload Performance: Intel Xeon 8462Y+ vs AMD Genoa 9354



Greater Performance And Efficiency On A Broad Range of Real-World Workloads

intel.

See backup for workloads and configurations. Results may vary.

Source: Intel



intel

Intel® Xeon® CPU Max Series

64GB	>1GB
HBM2e in 4 stacks of 16GB	HBM2e per P-core
Mem Modes	
HBMonly	Flat
Cache	

oneAPI

Seamlessly Scale Software

2023 Release Ext. SYCL Support Enhanced CUDA to SYCL Optimizations for TF & PyT

4th Gen Intel® Xeon® Scalable Processor
Up to 1.6x **Up to 2.6x**

Performance vs Intel® Xeon® 8380 processor on Industry Benchmarks

Performance uplift across wide range of workloads vs. Intel® Xeon® 8380 processor

Up to 20x
NLP Speed up

Numenta on 2S Intel® Xeon® Max CPU vs. AMD Milan

Only x86

CPU with High Bandwidth Memory

intel.
xeon

MAX SERIES

intel.
xeon

DATA CENTER GPU

MAX SERIES

Maximize Impact

Up to 5x
Performance vs Intel® Xeon® 8380 processor (Stream Triad)

Up to 3.7x
Performance vs Intel® Xeon® 8380 processor

- Anelastic Wave Propagation
- Standard Staggered Grid
- MPAS-A
- NEMO
- OpenFOAM
- CosmoFlow

Better Together
Max Series CPU & GPU
Up to 12.9x
Performance vs Intel® Xeon® 8380 LAMMPS.9 (Liquid Crystal Workload)

Max Series 1100 GPU	300W
Max Series 1350 GPU	450W
Max Series 1550 GPU	600W
Max Series Subsystem	1800W
Max Series Subsystem	2400W

intel
xeon Accelerate with Xeon

This offering is not approved or endorsed by OpenCFD Limited, producer and distributor of the OpenFOAM software via www.openfoam.com, and owner of the OPENFOAM® and OpenCFD® trademark.

See backup for workloads and configurations. Results may vary.



intel

Source: Intel

Numbering Convention

Intel Xeon Max	9	4	#	#	a	a
Intel Xeon Platinum	8	4	#	#	a	a
Intel Xeon Gold	6	4	#	#	a	a
Intel Xeon Gold	5	4	#	#	a	a
Intel Xeon Silver	4	4	#	#	a	a
Intel Xeon Bronze	3	4	#	#	a	a

SKU Shelf

- 9 = Max
- 8 = Platinum
- 6 = Gold
- 5 = Gold
- 4 = Silver
- 3 - Bronze

Generation

- “1” = 1st Gen (Skylake)
- “2” = 2nd Gen (Cascade Lake + Refresh)
- “3” = 3rd Gen (Ice Lake & Cooper Lake)
- “4” = 4th Gen (Sapphire Rapids)

Processor SKU

- Ex. 20, 34

Workload Optimized	Built-in Accelerators*					Up to Socket/UPI	SKU Shelf
	AMX	DSA	IAA	DLB	QAT		
P Cloud-IaaS	✓	1	1	1	1	2S/3UPI	P
V Clous-SaaS	✓	1	1	1	1	2S/3UPI, 1S	P
M Media Transcode	✓	1	1			2S/3UPI	G6
H DB and Analytics	✓	4	4	4	4	8S/4UPI	P
	✓	1	1	2	2	4S/3UPI	G6
N Network / 5G / Edge (High TPT /Low latency)	✓	4	4	4	4	2S	P
	✓	1	2	2	2	2S, 1S	G6, G5
S Storage & HCI	✓	4	4	4	4	2S/3UPI	G6
	✓	1	2	2	2	2S/3UPI	G5
T Long-life / Hight Tcase	✓	1				2S/2UPI	S
U 1-Socket*	✓	1				1S	G6
Q Liquid Cooling	✓	1				2S/3UPI	P, G6
+	✓	1	1	1	1		

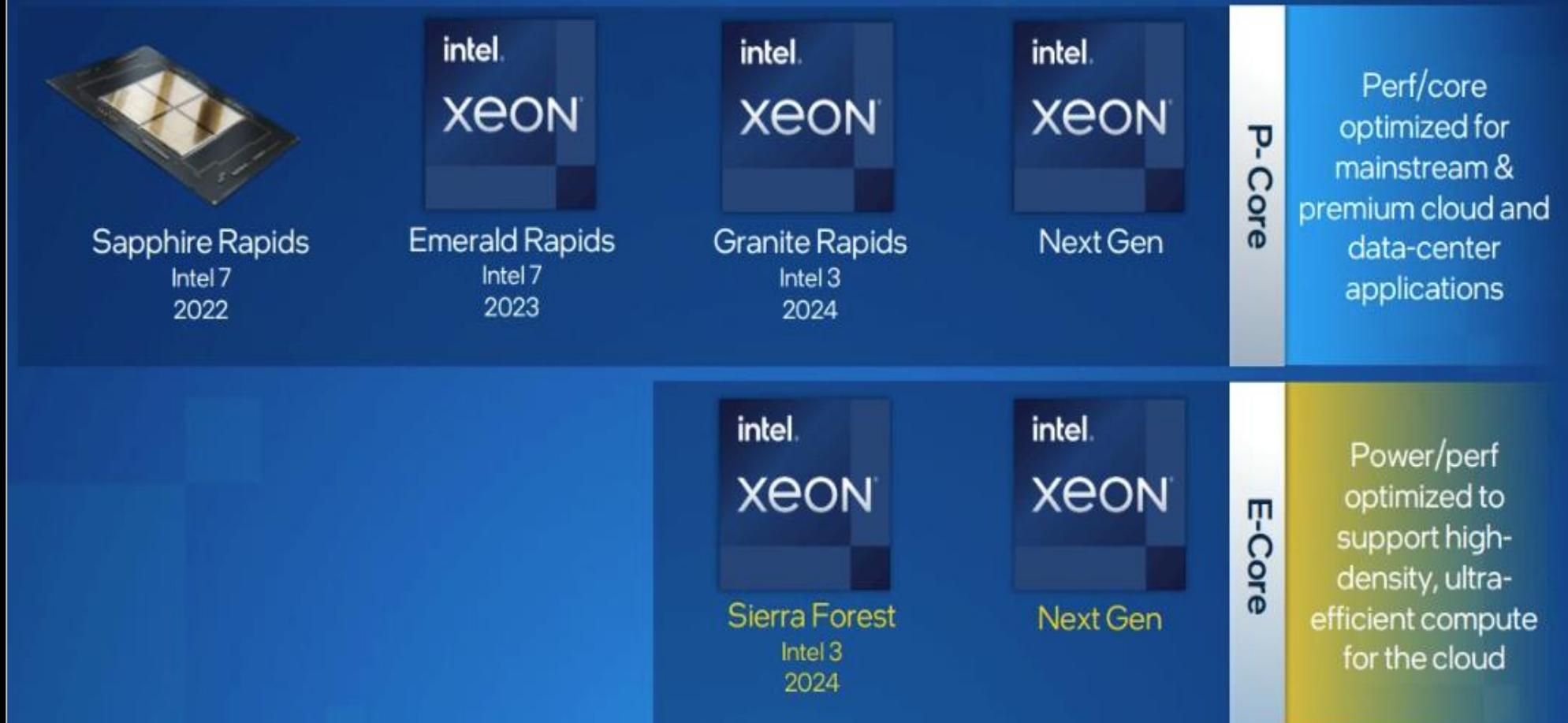
Notes:

- 1 to 4 Accelerator devices/instances supported on select SPR SKUs
- Accelerators not available on 1S Bronze SKUs

- AMX: Available on all Silver to Platinum SKUs;
- DSA: 1 device available on all SKUs.
- “Y” designator used for general SKU stack to highlight SST-PP feature enabled.
Workload optimized SKUs may have SST-PP enabled as well but will not have this designator.
Please refer to Workload specific details in their respective section.
- 1S Workload optimized SKUs will have a “1” digit before their respective letter (i.e. xxx1N)



Expanding the Intel Xeon Processor Roadmap

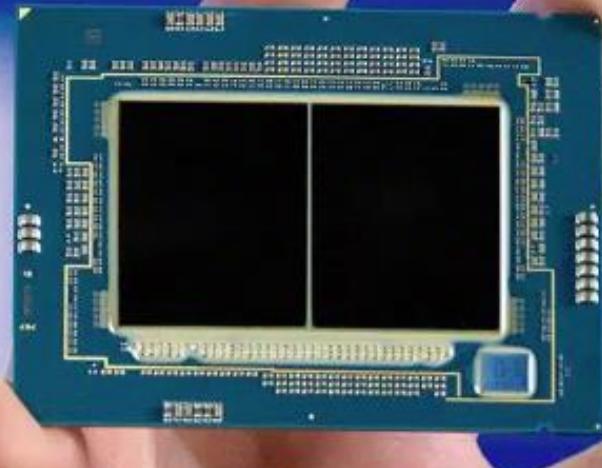


Source: Intel



intel

Nearest Future: Intel Xeon “Emerald Rapids”



- 2 Die
- up to 64 cores
- up to 320MB L3 Cache



intel

Selecting Criteria

Intel Processors for HPE Servers



Processor Number (SKU)	Cores	Threads	Frequency, GHz			Cache per chip, MiB		Memory				UPI Q-ty@Speed	TDP, W	Max Sockets	PCI Lanes & Gen	P MM	Target Use Case (Workload Optimization)	Core Count	SGX, GB	On Demand	Accelerators					
			Base	All Turbo	Max Turbo	L2	L3	Max, TiB	Type	Speed, MT/s	1DPC							Default (On Demand)								
																		QAT	DLB	DSA	IAA	AMX				
Max																										
9480	56	112	1,9	2,6	3,5	112	112,5	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	2S	80 x 5.0	-	High Performance Computing Optimized	HBM	512	—	0	0	4	0	+
9470	52	104	2,0	2,7	3,5	104	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	2S	80 x 5.0	-	High Performance Computing Optimized	HBM	512	—	0	0	4	0	+
9468	48	96	2,1	2,6	3,5	96	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	2S	80 x 5.0	-	High Performance Computing Optimized	HBM	512	—	0	0	4	0	+
9462	32	64	2,7	3,1	3,5	64	75,0	4,0	DDR5	4800	4400	8	3 @ 16GT/s	350	2S	80 x 5.0	-	High Performance Computing Optimized	HBM	128	—	0	0	4	0	+
9460	40	80	2,2	2,7	3,5	80	97,5	4,0	DDR5	4800	4400	8	3 @ 16GT/s	350	2S	80 x 5.0	-	High Performance Computing Optimized	HBM	128	—	0	0	4	0	+
Platinum																										
8490H	60	120	1,9	2,9	3,5	120	112,5	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	8S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	XCC	512	—	4	4	4	4	+
8480+	56	112	2,0	3,0	3,8	112	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	2S	80 x 5.0	+	Performance General Purpose	XCC	512	Y	1(4)	1(4)	1(4)	1(4)	+
8471N	52	104	1,8	2,8	3,6	104	97,5	4,0	DDR5	4800	4400	8	—	300	1S	80 x 5.0	+	5G / Networking Optimized	XCC	128 (512)	Y	4	4	4	0	+
8470Q	52	104	2,1	3,2	3,8	104	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	2S	80 x 5.0	+	Liquid Cooling General Purpose	XCC	512	Y	0	0	1(4)	0(4)	+
8470N	52	104	1,7	2,7	3,6	104	97,5	4,0	DDR5	4800	4400	8	3 @ 16GT/s	300	2S	80 x 5.0	+	5G / Networking Optimized	XCC	128 (512)	Y	4	4	4	0	+
8470	52	104	2,0	3,0	3,8	104	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	2S	80 x 5.0	+	Performance General Purpose	XCC	512	Y	0	0	1(4)	0(4)	+
8468H	48	96	2,1	3,0	3,8	96	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	330	8S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	XCC	512	—	4	4	4	4	+
8468V	48	96	2,4	2,9	3,8	96	97,5	4,0	DDR5	4800	4400	8	3 @ 16GT/s	330	2S	80 x 5.0	+	Cloud-Optimized / SaaS	XCC	128 (512)	Y	1	1	1(4)	1(4)	+
8468	48	96	2,1	3,1	3,8	96	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	350	2S	80 x 5.0	+	Performance General Purpose	XCC	512	Y	0	0	1(4)	0(4)	+
8462Y+	32	64	2,8	3,6	4,1	64	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	300	2S	80 x 5.0	+	Performance General Purpose	MCC	128 (512)	Y	1(2)	1(2)	1	1	+
8461V	48	96	2,2	2,8	3,7	96	97,5	4,0	DDR5	4800	4400	8	—	300	1S	80 x 5.0	+	Cloud-Optimized / SaaS	XCC	128 (512)	Y	1	1	1(4)	1(4)	+
8460H	40	80	2,2	3,1	3,8	80	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	330	8S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	XCC	512	—	0	0	4	4	+
8460Y+	40	80	2,0	2,8	3,7	80	105	4,0	DDR5	4800	4400	8	4 @ 16GT/s	300	2S	80 x 5.0	+	Performance General Purpose	XCC	128 (512)	Y	1(4)	1(4)	1(4)	1(4)	+
8458P	44	88	2,7	3,2	3,8	88	82,5	4,0	DDR5	4800	4400	8	3 @ 16GT/s	350	2S	80 x 5.0	+	Cloud-Optimized / IaaS	XCC	512	Y	1	1	1(4)	1(4)	+
8454H	32	64	2,1	2,7	3,4	64	82,5	4,0	DDR5	4800	4400	8	4 @ 16GT/s	270	8S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	XCC	512	—	4	4	4	4	+
8452Y	36	72	2,0	2,8	3,2	72	67,5	4,0	DDR5	4800	4400	8	4 @ 16GT/s	300	2S	80 x 5.0	+	Mainline General Purpose	XCC	128 (512)	Y	0	0	1(4)	0(4)	+
8450H	28	56	2,0	2,6	3,5	56	75	4,0	DDR5	4800	4400	8	4 @ 16GT/s	250	8S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	XCC	512	—	0	0	4	4	+
8444H	16	32	2,9	3,2	4,0	32	45	4,0	DDR5	4800	4400	8	4 @ 16GT/s	270	8S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	XCC	512	—	0	0	4	4	+

Note: X4XX Processor not [yet] supported by HPE Servers

Processor Number (SKU)	Cores	Threads	Frequency, GHz			Cache per chip, MiB		Memory				UPI Q-ty@Speed	TDP, W	Max Sockets	PCI Lanes & Gen	P M M	Target Use Case (Workload Optimization)	Core Count	SGX, GB	On Demand	Accelerators					
			Base	All Turbo	Max Turbo	L2	L3	Max, TiB	Type	Speed, MT/s	1DPC						Default (On Demand)									
																	QAT	DLB	DSA	IAA	AMX					
Gold																										
6458Q	32	64	3,1	4,0	4,0	64	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	350	2S	80 x 5.0	+	Liquid Cooling General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
6454S	32	64	2,2	2,8	3,4	64	60	4,0	DDR5	4800	4400	8	4 @ 16GT/s	270	2S	80 x 5.0	+	Storage and HCI Optimized	XCC	128 (512)	Y	4	4	4	0	+
6448H	32	64	2,4	3,2	4,1	64	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	250	4S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	MCC	512	—	2	2	1	1	+
6448Y	32	64	2,1	3,0	4,1	64	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	225	2S	80 x 5.0	+	Performance General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
6444Y	16	32	3,6	4,0	4,0	32	45	4,0	DDR5	4800	4400	8	3 @ 16GT/s	270	2S	80 x 5.0	+	Performance General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
6442Y	24	48	2,6	3,3	4,0	48	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	225	2S	80 x 5.0	+	Performance General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
6438Y+	32	64	2,0	2,8	4,0	64	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	205	2S	80 x 5.0	+	Mainline General Purpose	MCC	128 (512)	Y	1(2)	1(2)	1	1	+
6438N	32	64	2,0	2,7	3,6	64	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	205	2S	80 x 5.0	+	5G / Networking Optimized	MCC	128 (512)	Y	2	2	1	0(1)	+
6438M	32	64	2,2	2,8	3,9	64	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	205	2S	80 x 5.0	+	Cloud-Optimized / Media	MCC	128 (512)	Y	0	0	1	1	+
6434H	8	16	3,7	4,1	4,1	16	22,5	4,0	DDR5	4800	4400	8	3 @ 16GT/s	195	4S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	MCC	512	—	0	0	1	1	+
6434	8	16	3,7	4,1	4,1	16	22,5	4,0	DDR5	4800	4400	8	3 @ 16GT/s	195	2S	80 x 5.0	+	Performance General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
6430	32	64	2,1	2,6	3,4	64	60	4,0	DDR5	4400	4400	8	3 @ 16GT/s	270	2S	80 x 5.0	+	Mainline General Purpose	XCC	128 (512)	Y	0	0	1(4)	0(4)	+
6428N	32	64	1,8	2,5	3,8	64	60	4,0	DDR5	4000	4000	8	3 @ 16GT/s	185	2S	80 x 5.0	+	5G / Networking Optimized	MCC	128 (512)	Y	2	2	1	0(1)	+
6426Y	16	32	2,5	3,3	4,1	32	37,5	4,0	DDR5	4800	4400	8	3 @ 16GT/s	185	2S	80 x 5.0	+	Performance General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
6421N	32	64	1,8	2,6	3,6	64	60	4,0	DDR5	4400	4400	8	—	185	1S	80 x 5.0	+	5G / Networking Optimized	MCC	128 (512)	Y	0	0	1	0(1)	+
6418H	24	48	2,1	2,9	4,0	48	60	4,0	DDR5	4800	4400	8	3 @ 16GT/s	185	4S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	MCC	512	—	0	0	1	1	+
6416H	18	36	2,2	2,9	4,2	36	45	4,0	DDR5	4800	4400	8	3 @ 16GT/s	165	4S	80 x 5.0	+	IMDB/Analytics/Virtualization Optimized	MCC	512	—	0	0	1	1	+
6414U	32	64	2,0	2,6	3,4	64	60	4,0	DDR5	4800	4400	8	—	250	1S	80 x 5.0	+	Single-Socket General Purpose	XCC	128 (512)	Y	0	0	1(4)	0(4)	+
5433N	20	40	2,3	?	4,1	40	37,5	4,0	DDR5	4000	4000	8	—	160	1S	48 x 4.0	-	5G / Networking Optimized	MCC	128 (512)	Y	0	0	1	0	+
5423N	20	40	2,1	?	4,0	40	37,5	4,0	DDR5	4000	4000	8	—	145	1S	48 x 4.0	-	5G / Networking Optimized	MCC	128 (512)	Y	0	0	1	0	-
5420+	28	56	2,0	2,7	4,1	56	52,5	4,0	DDR5	4400	4400	8	3 @ 16GT/s	205	2S	80 x 5.0	+	Mainline General Purpose	MCC	128 (512)	Y	1(2)	1(2)	1	1	+
5418Y	24	48	2,0	2,8	3,8	48	45	4,0	DDR5	4400	4400	8	3 @ 16GT/s	185	2S	80 x 5.0	+	Mainline General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
5418N	24	48	1,8	2,6	3,8	48	45	4,0	DDR5	4000	4000	8	3 @ 16GT/s	165	2S	80 x 5.0	+	5G / Networking Optimized	MCC	128 (512)	Y	2	2	1	0(1)	+
5416S	16	32	2,0	2,8	4,0	32	30	4,0	DDR5	4400	4400	8	3 @ 16GT/s	150	2S	80 x 5.0	+	Storage and HCI Optimized	MCC	128 (512)	Y	2	2	1	0(1)	+
5415+	8	16	2,9	3,6	4,1	16	22,5	4,0	DDR5	4400	4400	8	3 @ 16GT/s	150	2S	80 x 5.0	+	Performance General Purpose	MCC	128 (512)	Y	1(2)	1(2)	1	1	+
5412U	24	48	2,1	2,9	3,9	48	45	4,0	DDR5	4400	4400	8	—	185	1S	80 x 5.0	+	Single-Socket General Purpose	MCC	128 (512)	Y	0	0	1	0(1)	+
5411N	24	48	1,9	2,8	3,9	48	45	4,0	DDR5	4400	4400	8	—	165	1S	80 x 5.0	+	5G / Networking Optimized	MCC	128 (512)	Y	2	2	1	0(1)	?
Silver																										
4416+	20	40	2,0	2,9	3,9	40	37,5	4,0	DDR5	4000	4000	8	2 @ 16GT/s	165	2S	80 x 5.0	-	Mainline General Purpose	MCC	64 (512)	Y	1(2)	1(2)	1	1	+
4410Y	12	24	2,0	2,8	3,9	24	30	4,0	DDR5	4000	4000	8	2 @ 16GT/s	150	2S	80 x 5.0	-	Mainline General Purpose	MCC	64 (512)	Y	0	0	1	0(1)	+
4410T	10	20	2,7	3,4	4,0	20	26,25	4,0	DDR5	4000	4000	8	2 @ 16GT/s	150	2S	80 x 5.0	-	Long-Life Use (IoT) General Purpose	MCC	64 (512)	Y	0	0	1	0(1)	+
Bronze																										
3408U	8	8	1,8	1,9	1,9	16	22,5	4,0	DDR5	4000	4000	8	—	125	1S	80 x 5.0	-	Single-Socket General Purpose	MCC	64	N	0	0	1	0	?

Note: X4XX Processor not [yet] supported by HPE Servers

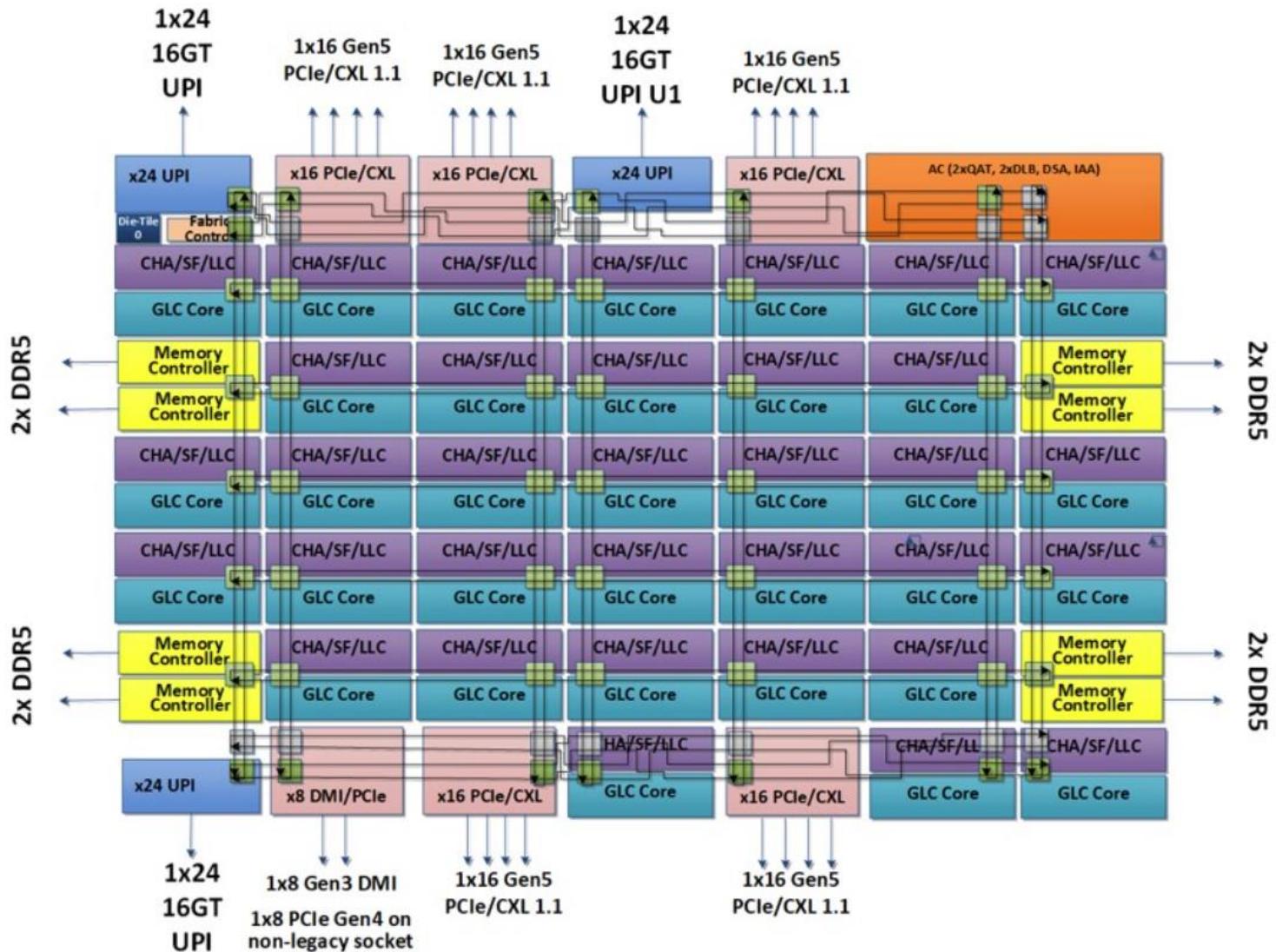
Processor Number (SKU)	Description (Base Frequency / Number of Cores / Memory Type and max Speed / max TDP)	Speed Select Technology				Default				SST - PP								SST - BF											
		Performance Profile	Base Frequency	Core Power	Turbo Frequency	Config 0				Config 1				Config 2				High Priority Cores		Low Priority Cores									
						Cores	Frequency, GHz			TDP, W	Cores	Frequency, GHz			TDP, W	Cores	Frequency, GHz			TDP, W	Q-ty	Freq., GHz	Q-ty	Freq., GHz					
Max																													
9480	Intel Xeon Max 9480 Processor (1.9GHz/56-core/DDR5-4800/64GB HBM/350W)	—	—	CP	—	56	1,9	2,6	3,5	350	48	2,1	?	?	350	32	2,6	?	?	350	40	2,2	2,7	3,5	350				
9470	Intel Xeon Max 9470 Processor (2.0GHz/52-core/DDR5-4800/64GB HBM/350W)	PP	—	CP	TF	52	2,0	2,7	3,5	350	40	2,2	?	?	350	36	2,4	?	?	350	32	2,6	?	?	350				
9468	Intel Xeon Max 9468 Processor (2.1GHz/48-core/DDR5-4800/64GB HBM/350W)	PP	—	CP	TF	48	2,1	2,6	3,5	350	32	2,7	3,1	3,5	350	36	2,4	?	?	350	32	2,6	?	?	350				
9462	Intel Xeon Max 9462 Processor (2.7GHz/32-core/DDR5-4800/64GB HBM/350W)	—	—	CP	—	32	2,7	3,1	3,5	350	32	2,7	3,1	3,5	350	36	2,4	?	?	350	32	2,6	?	?	350				
9460	Intel Xeon Max 9460 Processor (2.2GHz/40-core/DDR5-4800/64GB HBM/350W)	—	—	CP	—	40	2,2	2,7	3,5	350	32	2,7	3,1	3,5	350	36	2,4	?	?	350	32	2,6	?	?	350				
Platinum																													
8490H	Intel Xeon Platinum 8490H Processor (1.9GHz/60-core/DDR5-4800/350W)	—	BF	CP	TF	60	1,9	2,9	3,5	350	52	1,8	2,8	3,6	300	52	2,1	2,7	3,6	300	16	2	44	1,6	4,0	350			
8480+	Intel Xeon Platinum 8480+ Processor (2.0GHz/56-core/DDR5-4800/350W)	—	BF	CP	TF	56	2,0	3,0	3,8	350	48	2,1	3,0	3,8	330	48	2,1	2,7	3,6	300	16	2,1	36	1,7	4,0	350			
8471N	Intel Xeon Platinum 8471N Processor (1.8GHz/52-core/DDR5-4800/300W)	PP	BF	CP	TF	52	1,8	2,8	3,6	300	40	2,2	?	?	350	40	2,2	?	?	350	16	1,9	36	1,3	3,4	225			
8470Q	Intel Xeon Platinum 8470Q Processor (2.1GHz/52-core/DDR5-4800/350W)	—	BF	CP	TF	52	2,1	3,2	3,8	350	40	2,2	?	?	350	40	2,2	?	?	350	16	2,3	36	1,9	4,1	205			
8470N	Intel Xeon Platinum 8470N Processor (1.7GHz/52-core/DDR5-4800/300W)	PP	BF	CP	TF	52	1,7	2,7	3,6	300	40	2,2	?	?	350	40	2,2	?	?	350	16	1,8	36	1,3	4,1	205			
8470	Intel Xeon Platinum 8470 Processor (2.0GHz/52-core/DDR5-4800/350W)	—	BF	CP	TF	52	2,0	3,0	3,8	350	40	2,2	?	?	350	40	2,2	?	?	350	16	2,2	36	1,8	4,0	200			
8468H	Intel Xeon Platinum 8468H Processor (2.1GHz/48-core/DDR5-4800/330W)	—	BF	CP	TF	48	2,1	3,0	3,8	330	40	2,2	?	?	330	40	2,2	?	?	330	16	2,2	32	1,8	4,0	205			
8468V	Intel Xeon Platinum 8468V Processor (2.4GHz/48-core/DDR5-4800/330W)	PP	BF	CP	TF	48	2,4	2,9	3,8	330	40	2,1	2,7	3,7	300	40	1,8	2,4	3,5	270	16	2,5	32	2,1	4,0	185			
8468	Intel Xeon Platinum 8468 Processor (2.1GHz/48-core/DDR5-4800/350W)	—	BF	CP	TF	48	2,1	3,1	3,8	350	40	2,1	2,7	3,6	300	40	2,3	32	1,9	36	20	2,2	32	1,8	3,6	205			
8462Y+	Intel Xeon Platinum 8462Y+ Processor (2.8GHz/32-core/DDR5-4800/300W)	PP	BF	CP	TF	32	2,8	3,6	4,1	300	32	2,6	3,4	4,1	270	32	3,0	3,7	4,1	270	12	3,0	32	2,6	3,9	165			
8461V	Intel Xeon Platinum 8461V Processor (2.2GHz/48-core/DDR5-4800/300W)	PP	BF	CP	TF	48	2,2	2,8	3,7	300	40	1,9	2,5	3,4	270	40	1,7	2,3	3,5	250	16	2,3	32	1,9	2,5	165			
8460H	Intel Xeon Platinum 8460H Processor (2.2GHz/40-core/DDR5-4800/330W)	—	BF	CP	TF	40	2,2	3,1	3,8	330	40	2,2	?	?	330	40	2,4	28	2,0	330	12	3,9	6	3,3	2,0	330			
8460Y+	Intel Xeon Platinum 8460Y+ Processor (2.0GHz/40-core/DDR5-4800/300W)	PP	BF	CP	TF	40	2,0	2,8	3,7	300	36	2,1	2,8	3,7	300	36	2,3	2,9	3,7	300	12	2,1	28	1,7	12	2,2	20	1,8	
8458P	Intel Xeon Platinum 8458P Processor (2.7GHz/44-core/DDR5-4800/350W)	PP	—	CP	TF	44	2,7	3,2	3,8	350	40	2,7	3,1	3,8	330	40	2,7	3,1	3,8	330	12	2,1	28	2,0	3,8	185			
8454H	Intel Xeon Platinum 8454H Processor (2.1GHz/32-core/DDR5-4800/270W)	—	BF	CP	TF	32	2,1	2,7	3,4	270	32	1,9	2,5	3,2	270	32	2,2	20	1,8	270	12	1,9	20	1,5	4,1	150			
8452Y	Intel Xeon Platinum 8452Y Processor (2.0GHz/36-core/DDR5-4800/300W)	PP	BF	CP	TF	36	2,0	2,8	3,2	300	32	1,9	2,5	3,2	270	32	2,1	2,5	3,2	250	12	2,2	24	1,8	3,6	185			
8450H	Intel Xeon Platinum 8450H Processor (2.0GHz/28-core/DDR5-4800/250W)	PP	BF	CP	TF	28	2,0	2,6	3,5	250	24	1,9	2,3	3,2	225	24	1,9	2,1	3,1	205	8	2,1	20	1,7	4,0	185			
8444H	Intel Xeon Platinum 8444H Processor (2.9GHz/16-core/DDR5-4800/270W)	—	—	CP	TF	16	2,9	3,2	4,0	270	16	2,9	3,2	4,0	270	16	2,4	165	6	2,4	12	2,0	12	2,1	20	1,6			
6414U		Intel Xeon Gold 6414U Processor (2.0GHz/32-core/DDR5-4800/250W)				—	BF	CP	TF	32	2,0	2,6	3,4	250	32	2,0	2,6	3,4	250	16	2,1	20	1,6	4,0	250				
5433N	Intel Xeon Gold 5433N Processor (2.3GHz/20-core/DDR5-4000/160W)	PP	—	CP	TF	20	2,3	?	4,1	160	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?			
5423N	Intel Xeon Gold 5423N Processor (2.1GHz/20-core/DDR5-4000/145W)	PP	—	CP	TF	20	2,1	?	4,0	145	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?			
5420+	Intel Xeon Gold 5420+ Processor (2.0GHz/28-core/DDR5-4400/205W)	—	BF	CP	TF	28	2,0	2,7	4,1	205	24	2,0	2,8	3,8	185	16	2,3	3,1	3,8	165	12	2,7	3,2	3,8	165	8	2,2	20	1,8
5418Y	Intel Xeon Gold 5418Y Processor (2.0GHz/24-core/DDR5-4400/185W)	PP	BF	CP	TF	24	2,0	2,8	3,8	185	24	1,7	2,6	3,8	165	24	1,9	2,6	3,8	165	8	2,2	16	1,7	4,0	185			
5418N	Intel Xeon Gold 5418N Processor (1.8GHz/24-core/DDR5-4000/165W)	PP	BF	CP	TF	24	1,8	2,6	3,8	165	24	1,7	2,6	3,8	165	24	1,9	2,6	3,8	165	8	2,0	16	1,6	4,1	150			
5416S	Intel Xeon Gold 5416S Processor (2.0GHz/16-core/DDR5-4400/150W)	PP	BF	CP	TF	16	2,0	2,8	4,0	150	12	1,9	2,8	4,0	135	8	2,5	3,1	4,0	135	4	2,1	12	1,7	4,1	125			
5415+	Intel Xeon Gold 5415+ Processor (2.9GHz/8-core/DDR5-4400/150W)	—	BF	CP	TF	8	2,9	3,6	4,1	150	8	2,9	3,6	4,1	150	8	2,5	3,1	4,0	135	2	3,1	6	2,7	4,1	125			
5412U	Intel Xeon Gold 5412U Processor (2.1GHz/24-core/DDR5-4400/185W)	—	BF	CP	TF	24	2,1	2,9	3,9	185	24	1,9	2,8	3,9	165	24	2,1	2,8	3,9	165	8	2,3	16	2,0	4,1	125			
5411N	Intel Xeon Gold 5411N Processor (1.9GHz/24-core/DDR5-4400/165W)	PP	BF	CP	TF	24	1,9	2,8	3,9	165	24	1,9	2,8	3,9	165	24	2,1	2,8	3,9	165	8	2,1	16	1,7	4,1	125			
Silver																													
4416+	Intel Xeon Silver 4416+ Processor (2.0GHz/20-core/DDR5-4000/165W)	—	—	—	—	20	2,0	2,9	3,9	165	12	2,0	2,8	3,9	150	8	2,0	2,9	3,9	130	6	2,2	3,2	3,9	125	4,0	165		
4410Y	Intel Xeon Silver 4410Y Processor (2.0GHz/12-core/DDR5-4000/150W)	PP	—	—	—	12	2,0	2,8	3,9	150	8	2,2	3,1	4,0	150	8	2,2	3,1	4,0	125	6	2,7	3,3	4,0	125	4,0	150		
4410T	Intel Xeon Silver 4410T Processor (2.7GHz/10-core/DDR5-4000/150W)	PP	—	CP	—	10	2,7	3,4	4,0	150	8	2,2	3,1	4,0	125	6	2,7	3,3	4,0	125	4,0	150	4,0	150	4,0	150			
Bronze																													
3408U	Intel Xeon Bronze 3408U Processor (1.8GHz/8-core/DDR5-4000/125W)	—	—	—	—	8	1,8	1,9	1,9	125	8	2,0	2,9	3,9	125	8	2,0	2,9	3,9	125	4,0	125	4,0	125	4,0	125			

Note: **X4XX** Processor not [yet] supported by HPE Servers

MCC Die Details

Medium Core Count

- Monolithic Architecture
- Up to 32 cores
- Cache Memory - 2.0 MB L2 per Core, up to 60 MB L3 per Chip
- 4 Dual-Channel DDR5 Memory Controllers
- 3 or 2 x24 UPI 2.0 Links
- 5 x16 PCIe 5.0 / CXL 1.1 Controllers
- 1 x8 DMI Gen3 / PCIe 4.0 Controller
- 1 Accelerators Block :
1 x DSA; 0 or 1 x IAA;
0, 1, (or 2) x QAT; 0, 1, (or 2) x DLB

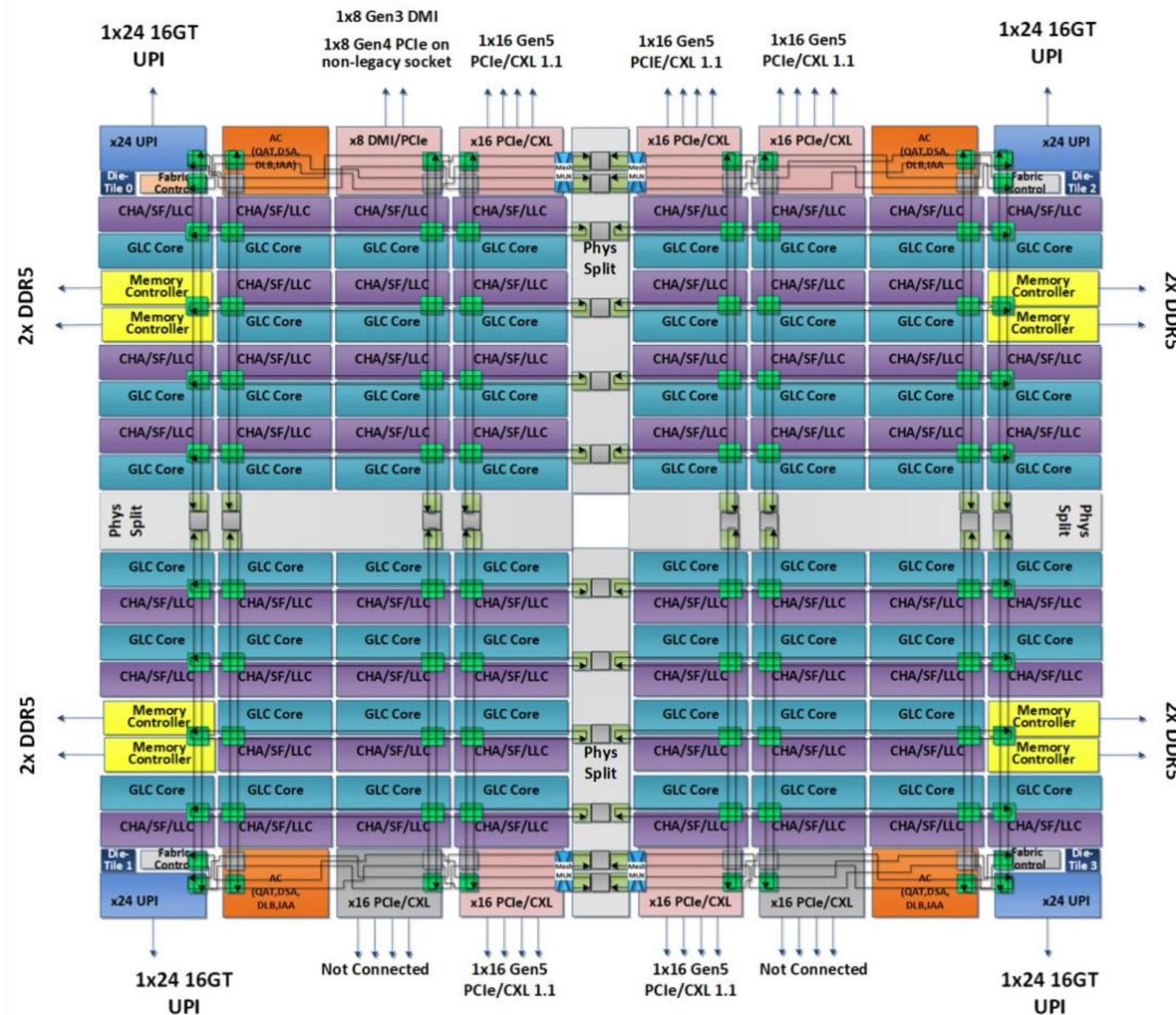


intel

XCC Die Details

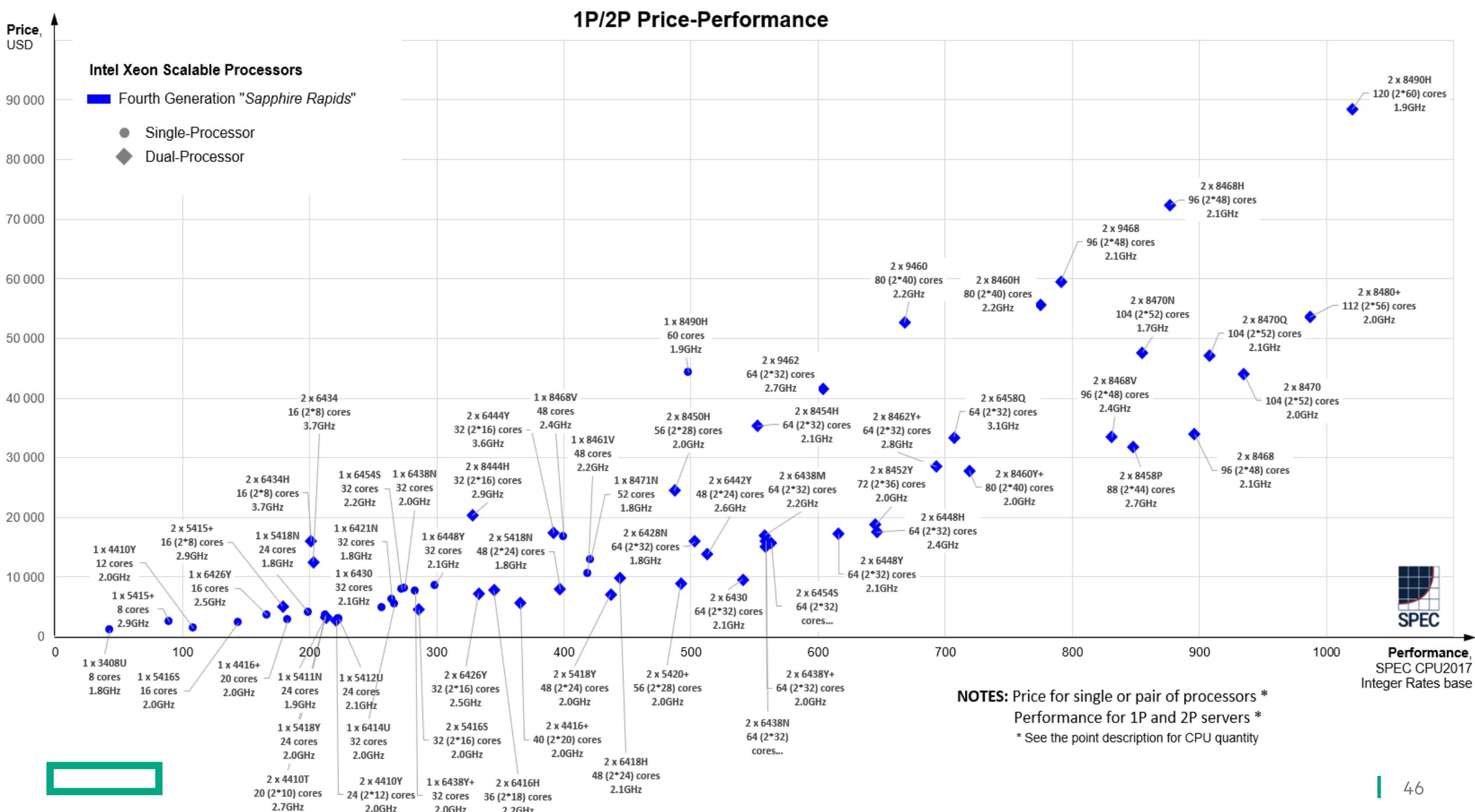
Extreme Core Count

- 4 Dies per Chip, 10 Embedded Multi-Die Interconnect Bridge (EMIB) connections
- Up to 15 Cores per Die, 60 per Chip
- Cache Memory - 2.0 MB L2 per Core, up to 112.5 MB L3 per Chip
- 4 Dual-Channel DDR5 Memory Controllers, One per Die
- 4 or 3 x24 UPI 2.0 Links
- 5 x16 PCIe 5.0 / CXL 1.1 Controllers, One or Two per Die
- 1 x8 DMI Gen3 / PCIe 4.0 Controller, on the Die 0
- 1 Accelerators Block per Die, 4 per Chip:
1 or 4 x DSA; 0, 1 or 4 x IAA;
0, 1, or 4 x QAT; 0, 1, or 4 x DLB



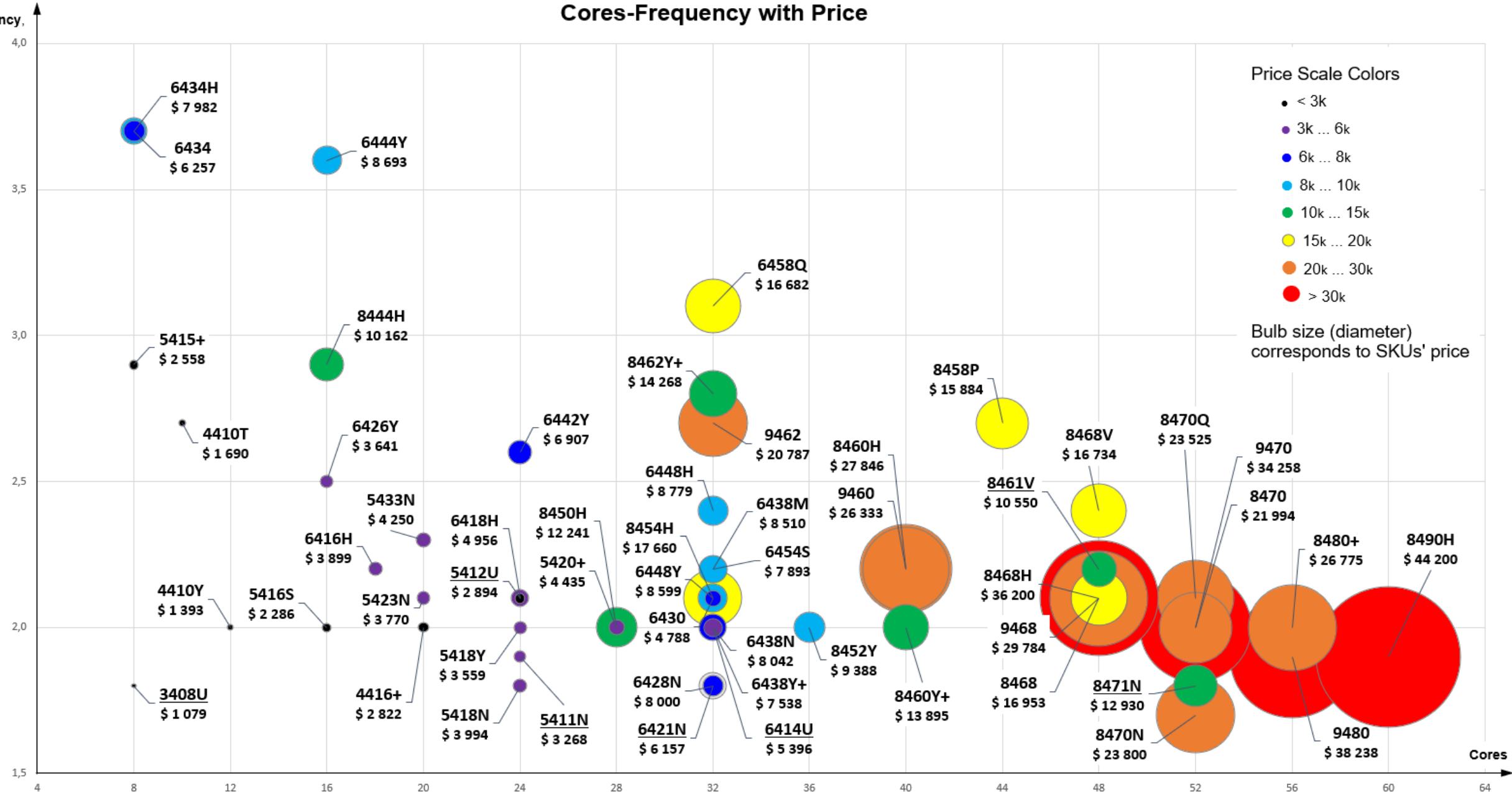
intel

1P/2P Price-Performance



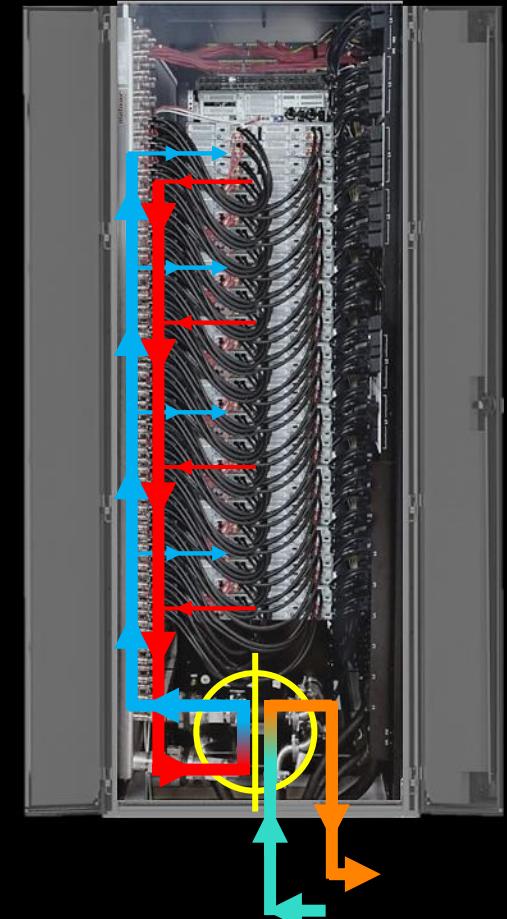
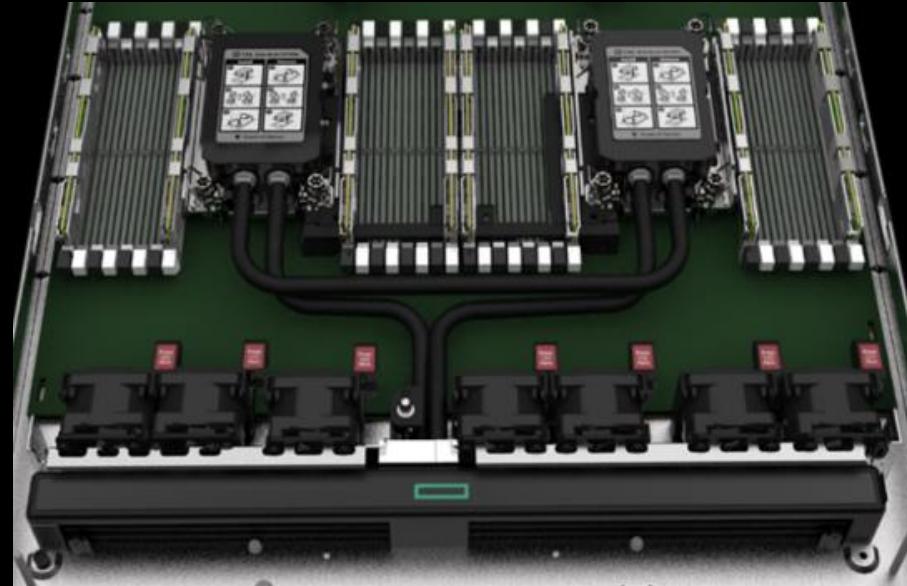
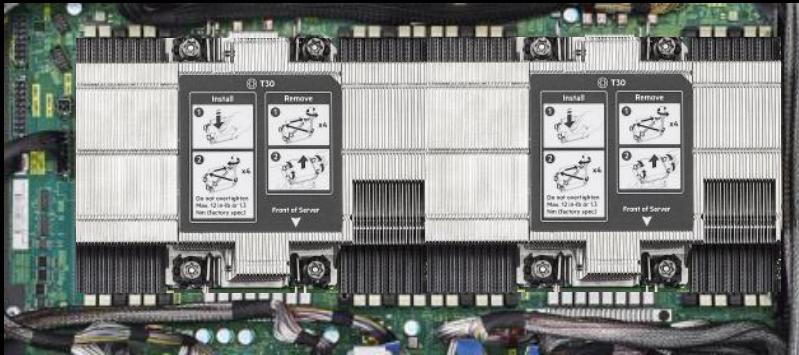
NOTES: Price for single or pair of processors *
Performance for 1P and 2P servers *

Cores-Frequency with Price



NOTE: Single-socket only SKUs underlined

Processor Cooling Options



Availability / Lead Time

P49655-B21	Intel Xeon-Platinum 9468 2.1GHz 48-core 350W Processor for HPE	 42
P49645-B21	Intel Xeon-Platinum 9462 2.7GHz 32-core 350W Processor for HPE	 42
P49630-B21	Intel Xeon-Platinum 8490H 19GHz 60-core 350W Processor for HPE	 28
P49607-B21	Intel Xeon-Platinum 8480+ 2.0GHz 56-core 350W Processor for HPE	 28
P49625-B21	Intel Xeon-Platinum 8444H 2.9GHz 16-core 270W Processor for HPE	 4
P49608-B21	Intel Xeon-Gold 6458Q 3.1GHz 32-core 350W Processor for HPE	 28
P49654-B21	Intel Xeon-Gold 6454S 2.2GHz 32-core 270W Processor for HPE	 28
P49599-B21	Intel Xeon-Gold 6442Y 2.6GHz 24-core 225W Processor for HPE	 4
P49615-B21	Intel Xeon-Gold 6438Y+ 2.0GHz 32-core 205W Processor for HPE	 4

Current Availability Status

 Short time

 Mid time

 Long time

Working days to option availability
on the factory production line

EDT, Estimated Delivery Time



Selecting Criteria

- Core Count
- Base Frequency
- All-Cores Turbo Frequency
- SST Profiles
- Memory Speed
- Cache Memory Size
- HBM on-Chip
- UPI Links q-ty
- Built-in Accelerators
- SGX Enclave Size
- Socket Scalability
- TDP / Cooling
- Performance
- Performance-per-Core
- Performance-per-Watt
- Performance-per-Price
- Processor Price
- Availability / Delivery Time



Do you have one more?



Q & A



Thank You

Alexander Golovchenko

HPE Servers Product Manager

Alexander.Golovchenko@hpe.ua

+380 (67) 577-19-98

Sophela LLC, HPE Master Area Partner

110 Zhylyanska str., 6th floor,

Kyiv 01032, Ukraine

